

**Bachelor and Master of Technology  
(Dual Degree)  
Detailed Syllabus**

Course Title	Course Code	Structure (I-P-C)		
<b>Basic Electrical and Electronics Engineering</b>	<b>EC101</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Nil

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Develop and employ circuit models for elementary electronic components and circuit analysis.
<b>CO2</b>	Analyze the voltage and current of an electric circuit using network theorems.
<b>CO3</b>	Understand the behaviour of the transient states in RL, RC, RLC circuits.
<b>CO4</b>	Understand PN junction diodes and its circuits.
<b>CO5</b>	Design the electric circuits with passive and active components.

**Syllabus:**

Electrical circuit elements: voltage and current sources, R,C,L,M,I,V, linear, non-linear, active and passive elements, inductor current and capacitor voltage continuity, Kirchhoff's laws, Elements in series and parallel, superposition in linear circuits, controlled sources, energy and power in elements, energy in mutual inductor and constraint on mutual inductance.

Network analysis: Nodal analysis with independent and dependent sources, super nodal analysis, mesh analysis, super mesh analysis.

Network theorems: superposition theorem, substitution theorem, Millman's theorem, Tellegen's theorem, reciprocity theorem, Thevenin's and Norton's theorems, pushing a voltage source through a node, splitting a current source, compensation theorem, maximum power transfer theorem.

RC and RL circuits: natural, step and sinusoidal steady state responses, series and parallel RC/RL/RLC circuits, steady state and transient response, resonance.

AC signal measures: complex, apparent, active and reactive power, power factor. Magnetic circuits: self-inductance, mutual inductance, dot convention, series/parallel connection of coils. Two port network functions: z, y, h, g, T, and t parameters; conversion of one parameter to another, condition for the reciprocity and symmetry.

Network topology: notion of network graphs, nodes, trees, twigs, links, co-tree, independent sets of branch currents and voltages, incidence matrix, tie set matrix, cut set matrix

Introduction to three phase supply: three phase circuits, star-delta transformations, balanced and unbalanced three phase load, power measurement, two wattmeter method.

Semiconductor diodes and application: PN diodes, rectifiers, and filters, clipping and clamping circuits.

**Text Book(s):**

1. Hayt. W. W, Kemmerly. J.E, and Durbin. S.M, Engineering Circuits Analysis, 8<sup>th</sup> edition, Tata McGraw Hill, 2013.
2. J. David Irwin and R. Mark Nelms, Basic Engineering Circuit Analysis, 10<sup>th</sup> edition, Wiley, 2011

**References & Web Resources:**

1. Hughes Edward, Electrical & Electronic Technology, 10<sup>th</sup> edition, Pearson Education, 2007.
2. Hambley. A, Electrical Engineering Principles and Applications: International Version, Pearson Education, 4 Edn, 2007.
3. Alexander.C. K. & Mathew. N. O. Sadiku, Fundamentals of Electrical circuits, 5<sup>th</sup> edition, Tata McGraw Hill, 2008.

Course Title	Course Code	Structure (I-P-C)		
<b>Electronic Devices and Circuits</b>	<b>EC151</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Basic Electrical and Electronics Engineering

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the principles and characteristics of different types of semiconductor devices.
<b>CO2</b>	Understand the fabrication process of semiconductor devices.
<b>CO3</b>	Utilize the mathematical models of semiconductor junctions and MOS transistors for circuits and systems
<b>CO4</b>	Understand the constructional details and characteristics of Diode, BJT, and MOS Devices.
<b>CO5</b>	Understand the characteristics of special diodes.

**Syllabus:**

Semiconductor Basics: Bonding forces, Energy bands in Solids, Metals, Semiconductors and Insulators, Direct and Indirect semiconductors, Electrons and Holes, Intrinsic and Extrinsic materials, Conductivity and Mobility, Drift and Resistance, Effects of temperature and doping on mobility, Hall Effect.

P-N Junctions: Forward and Reverse biased junctions- Qualitative description of Current flow at a junction, reverse bias, Reverse bias breakdown- Zener breakdown, avalanche breakdown, Rectifiers, Optoelectronic Devices Photodiodes: Current and Voltage in an Illuminated Junction, Solar Cells, Photo detectors. Light Emitting Diode: Light Emitting materials.

Bipolar Junction Transistor: Fundamentals of BJT operation, Amplification with BJTS, BJT Fabrication, The coupled Diode model (Ebers-Moll Model), Switching operation of a transistor, Cutoff, saturation, switching cycle, specifications, Drift in the base region, Base narrowing, Avalanche breakdown.

Field Effect Transistors: Basic JFET Operation, Equivalent Circuit and Frequency Limitations, MOSFET Two terminal MOS structure- Energy band diagram, Ideal Capacitance – Voltage Characteristics and Frequency Effects, Basic MOSFET Operation- MOSFET structure, Current-Voltage Characteristics.

Fabrication of P-N Junctions: Thermal Oxidation, Diffusion, Rapid Thermal Processing, Ion implantation, chemical vapour deposition, photolithography, Etching, metallization.

Integrated Circuits: Background, Evolution of ICs, CMOS Process Integration, Integration of Other Circuit Elements.

**Text Book(s):**

1. Ben. G. Streetman, Sanjay Kumar Banergee, “Solid State Electronic Devices”, 7<sup>th</sup> Edition, Pearson Education.
2. Donald A Neamen, Dhruves Biswas, “Semiconductor Physics and Devices”, 4th Edition, MCGraw Hill Education, 2012.

**References & Web Resources:**

1. S. M. Sze, Kwok K. Ng, “Physics of Semiconductor Devices”, 3rd Edition, Wiley, 2018.

Course Title	Course Code	Structure (I-P-C)		
<b>Signals and Systems</b>	<b>EC152</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Nil

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand various properties of continuous time signals.
<b>CO2</b>	Analyze the frequency spectrum of continuous time signals.
<b>CO3</b>	Describe a LTI system by impulse/frequency response.
<b>CO4</b>	Analyze magnitude/phase response of various LTI systems.
<b>CO5</b>	Analyze systems commonly used in Communications, Control, and Signal Processing.

**Syllabus:**

Introduction to Continuous/Discrete time Signals and Systems: The unit impulse and unit step functions, Continuous-time signals, Transformations of the independent variables, Exponential and Sinusoidal signals, Continuous-time systems and basic system properties.

Linear Time-invariant Discrete/Continuous Systems: Continuous-time Linear Time-invariant (LTI) system, Discrete-time LTI system, Properties of LTI systems, System representation through linear constant coefficient differential equations.

Discrete/Continuous Fourier Series Representation of Periodic Signals: Fourier series representation of continuous/discrete time periodic signals, Convergence of the Fourier series, Properties of continuous/discrete time Fourier series, Fourier series and LTI systems, Filtering, Examples of continuous-time filters described by differential equations.

Discrete/Continuous-time Fourier Transform: Representation of aperiodic signals, The Fourier transform for periodic signals, Properties of the continuous-time Fourier transform, Convolution and multiplication properties and their effect in the frequency domain, magnitude and phase response.

Laplace Transform: The Laplace transform for continuous-time signals and systems, the notion of Eigenvalue and Eigenfunctions of LTI systems, Region of convergence, System functions, Poles and zeros of system functions and signals, Properties of the Laplace transform, Analysis and characterization of LTI systems using the Laplace transform, The unilateral Laplace transform.

Z-transform: Introduction of z-transform, Properties of the region of convergence of the z-transform, The inverse z-transform, Properties of the z-transform, solving the difference equations using Z-transform.

**Text Book(s):**

1. A. V. Oppenheim, A. S. Willsky, and S. H. Nawab, "Signals and Systems," 2<sup>nd</sup> Edition, Prentice Hall, 2003.
2. S. Haykin and B. V. Veen, "Signals and Systems" 2<sup>nd</sup> Edition, Wiley, 2007.

**References & Web Resources:**

1. B.P. Lathi, "Principles of Linear Systems and Signals," Oxford University Press, 2<sup>nd</sup> Edition, 2009.

Course Title	Course Code	Structure (I-P-C)		
<b>Digital Logic Circuits</b>	<b>EC201</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Nil

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand various number systems and their representation
<b>CO2</b>	Design combinational circuits
<b>CO3</b>	Design sequential circuits
<b>CO4</b>	Formulate logic and design circuits for practical problems.
<b>CO5</b>	Understand the issues at the digital circuits.

**Syllabus:**

Representation of Data: Introduction, Data representations, Number systems, conversions and codes.

Switching Theory: Laws and theorems of Boolean algebra, switching functions, truth table and algebraic form, realization using logic gates.

Digital Logic and Implementation: K-Maps, QM method, SOP, POS; NAND and NOR implementation, Digital Circuit Characterization.

Combinational Circuit Design: Design Procedure, Multiplexer, Decoder, Encoder, Comparator, Seven-segment display, Parity generator, Design of large circuits, Ripple Carry Adder, Carry look ahead adder, carry save adder, carry save array multiplier, Wallace tree multiplier, Restoring/Non Restoring division techniques.

Asynchronous and Synchronous Sequential Circuit Design; Design of sequential modules – SR, D, T and J-K Flip-flops, applications, Clock generation, Clock dividers, Registers, and Counters.

Design using State machines: Moore and Mealy machines, Design Examples.

Issues at the Digital Circuits: Glitches, Glitch free circuit design, Static and Dynamic Hazards, Hazard resolution techniques, Race, and Cycles.

**Text Book(s):**

1. C. H. Roth, Jr., "Fundamentals of Logic Design," 7th Edition, Cengage Learning, 2013.
2. S. Brown and Z. Vranesic, "Fundamentals of Digital Logic with VHDL Design," TMH, 3<sup>rd</sup> Edition

**References & Web Resources:**

1. J. F. Wakerly, "Digital Design- Principles and Practices," 3<sup>rd</sup> Edition, Pearson
2. M. M. Mano, "Digital Design," PHI.
3. T. L. Floyd and R. P. Jain, "Digital Fundamentals," 8<sup>th</sup> Edition, Pearson.

Course Title	Course Code	Structure (I-P-C)		
<b>Electromagnetic Waves and Transmission Lines</b>	<b>EC204</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Nil

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the principles of vector algebra, vector calculus, and their physical interpretations in electromagnetic fields
<b>CO2</b>	Analyse Maxwell's equations for time-varying electromagnetic fields and understand the formation and characteristics of electromagnetic wave
<b>CO3</b>	Understand the plane wave reflections and wave dispersion in different mediums
<b>CO4</b>	Apply Maxwell's equations for solutions in transmission lines
<b>CO5</b>	Illustrate the wave propagation through different waveguides

**Syllabus:**

Vector Analysis: Scalars and Vectors, Vector Algebra, The Rectangular Coordinate System, Vector Components and Unit Vectors, The Vector Field, The Dot Product, The Cross Product, Other Coordinate Systems: Cylindrical Coordinates and The Spherical Coordinate System

Time-Varying Fields and Maxwell's Equations: Faraday's Law, Displacement Current, Maxwell's Equations in Point Form, Maxwell's Equations in Integral Form, The Retarded Potentials

The Uniform Plane Wave: Wave Propagation in Free Space, Wave Propagation in Dielectrics, Poynting's Theorem and Wave Power, Propagation in Good Conductors: Skin Effect, Wave Polarization

Plane Wave Reflection and Dispersion: Reflection of Uniform Plane Waves at Normal Incidence, Standing Wave Ratio, Wave Reflection from Multiple Interfaces, Plane Wave Propagation in General Directions, Plane Wave Reflection at Oblique Incidence

Angles, Total Reflection and Total Transmission of Obliquely Incident Waves, Wave Propagation in Dispersive Media, Pulse Broadening in Dispersive Media

Transmission Lines: Physical Description of Transmission Line Propagation, The Transmission Line Equations, Lossless Propagation, Lossless Propagation of Sinusoidal Voltages, Complex Analysis of Sinusoidal Waves, Transmission Line Equations and Their Solutions in Phasor Form, Low-Loss Propagation, Power Transmission and The Use of Decibels in Loss Characterization, Wave Reflection at Discontinuities, Voltage Standing Wave Ratio, Transmission Lines of Finite Length, Some Transmission Line Examples, Graphical Methods: The Smith Chart, Transient Analysis

Guided Waves: Transmission Line Fields and Primary Constants, Basic Waveguide Operation, Plane Wave Analysis of the Parallel-Plate Waveguide, Parallel-Plate Guide Analysis Using the Wave Equation, Rectangular Waveguides, Planar Dielectric Waveguides, Optical Fibre.

**Text Book(s):**

1. Matthew N.O. Sadiku, S.V. Kulkarni, Principles of Electromagnetics, 6th Edition, Oxford, 2015.
2. W. H. Hayt and J. A. Buck, Engineering Electromagnetics, Tata McGraw Hill Education Pvt. Ltd, 2006.

**References & Web Resources:**

1. Rao, Nannapaneni Narayana. Elements of engineering electromagnetics. Prentice Hall, 1991.
2. Griffiths, David J. "Introduction to Electrodynamics, 4th Edition, 2021.

Course Title	Course Code	Structure (I-P-C)		
<b>Analog Electronics</b>	<b>EC202</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Electronic Devices and Circuits

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand analog circuits.
<b>CO2</b>	Analyse and design of amplifiers viz. VCVS, VCCS, CCVS, CCCS
<b>CO3</b>	Analyse and design of analog circuits with operational amplifiers.
<b>CO4</b>	Analyse and design the analog filters.
<b>CO5</b>	Design oscillators and multivibrators.

**Syllabus:**

Device Models: (Diode, BJT, MOSFET); Small signal analysis of nonlinear circuits, small signal equivalent of diode, BJT, MOSFET.

Biasing: Adding dc bias to ac signals, Concept of ac coupling, current mirrors, Cascode current mirrors.

Basic transistor Amplifiers: small signal and large signal (low frequency) characteristics, VCVS, VCCS, CCVS, CCCS, high frequency effects.

Differential pair: Need of active load, differential amplifier.

OpAmp internal circuitry: 2-stage plus buffer example, Miller compensation of a 2-stage OpAmp, Stability, frequency compensation.

OpAmp circuits: Amplifier Circuits, Filters, oscillators.

**Text Book(s):**

- 1.B. Razavi, "Fundamentals of Microelectronics," Wiley Student Edition, 2010.
- 2.S. Franco, "Design with Operational Amplifiers and Analog Integrated Circuits," McGraw-Hill Series in Electrical and Computer Engineering, 4th Edition, 2015.

**References & Web Resources:**

1. Sedra and Smith, "Microelectronic Circuits," 7 th Edition, Oxford University Press.
2. D. A. Newman, "Electronic circuits," 4 th Edition, TMH.

Course Title	Course Code	Structure (I-P-C)		
<b>Digital Logic Circuits Practice</b>	<b>EC205</b>	<b>0</b>	<b>3</b>	<b>2</b>

**Pre-requisite, if any:** Nil

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand digital circuits in practical prespective
<b>CO2</b>	Design Combinational circuits
<b>CO3</b>	Design sequential circuits
<b>CO4</b>	Formulate logic and design circuits for practical problems.
<b>CO5</b>	Design the digital circuits using HDL

**Experiments:**

1. Formulating Boolean expressions and truth tables from practical statements.
2. Designing logic circuits and simplifying using k-map,
3. Designing NAND-NAND & NOR-NOR diagrams & verifying the same by simulation and experiment.
4. Combinational circuits: code converters, arithmetic circuits, mux/demux, encoder/decoder, comparators etc.
5. Sequential circuits including flip flops, shift registers, counters, sequence generators etc.
6. Simple design examples with Moore and Mealy machines.
7. Digital circuits design using HDL
8. Implementation of combinational and sequential circuits in the digital trainer board.

**Text Book(s):**

1. C. H. Roth, "Fundamentals of Logic Design," 5<sup>th</sup> Edition, Thomson Books/Cole.
2. Samir Palnitkar: Verilog HDL - Guide to Digital design and synthesis, Pearson Guide to Digital design and synthesis, Pearson Education, 3rd Edn, 2003.

**References & Web Resources:**

1. S. Brown and Z. Vranesic, "Fundamentals of Digital Logic with VHDL Design," TMH, 3<sup>rd</sup> Edition.



Course Title	Course Code	Structure (I-P-C)		
<b>Analog Electronics Practice</b>	<b>EC206</b>	<b>0</b>	<b>3</b>	<b>2</b>

**Pre-requisite, if any:** Electronic Devices and Circuits

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand analog circuits.
<b>CO2</b>	Analyse and design of amplifiers viz. VCVS, VCCS, CCVS, CCCS
<b>CO3</b>	Analyse and design of analog circuits with operational amplifiers
<b>CO4</b>	Analyse and design the analog filters
<b>CO5</b>	Design oscillators and multivibrators.

**Experiments:**

1. Half wave and full wave rectifiers design,
2. Diode based clipper and clamper circuits design,
3. Voltage regulator design using Zener diode,
4. RC Circuit Analysis,
5. BJT voltage transfer characteristics analysis,
6. Operation amplifier analysis,
7. Circuits using Op-Amps, Filters, and Oscillators,
8. Common emitter amplifier design,
9. Analysis of common source characteristics of NMOS transistor,
10. Basic NMOS common source audio amplifier design,
11. Power Supply analysis
12. Frequency analysis of BJT and MOSFET

**Text Book(s):**

1. B. Razavi, "Fundamentals of Microelectronics," Wiley Student Edition, 2010.
2. S. Franco, "Design with Operational Amplifiers and Analog Integrated Circuits," McGraw-Hill Series in Electrical and Computer Engineering, 4th Edition, 2015.

**References & Web Resources:**

1. Sedra and Smith, "Microelectronic Circuits," 7<sup>th</sup> Edition, Oxford University Press.
2. D. A. Newman, "Electronic circuits," 4<sup>th</sup> Edition, TMH.

Course Title	Course Code	Structure (I-P-C)		
<b>Probability Theory and Statistics</b>	<b>DS151</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Nil

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the concept of probability using an appropriate samplespace.
<b>CO2</b>	Solve problems on discrete and continuous random variables.
<b>CO3</b>	Identify the characteristics of different discrete and continuous distributions.
<b>CO4</b>	Analyze the statistical problems on large and small samples.
<b>CO5</b>	Apply the knowledge of probability and statistics in solving engineering problems.

**Syllabus:**

**Introduction to Probability:** Sets, Events, Axioms of Probability, Conditional Probability and Independence, Bayes Theorem.

**Random Variables:** Definitions, Cumulative Distribution Functions, Probability Mass Function, Probability Density Function, Joint and Conditional Distributions.

**Expectations:** Mean, Variance, Moments, Correlation, Chebychev and Schwarz Inequalities, Moment-Generating and Characteristic Functions, Chernoff Bounds, Conditional Expectations, Law of Large Numbers, Central Limit Theorem. Uniform, Binomial, Poisson and Normal Distributions.

**Test for Large Samples:** Testing of Hypothesis –Null and alternate hypothesis, level of significance and critical region-Z-test for single mean and difference of means, single proportion and difference of proportions.

**Test for Small Samples:** t-test for single mean and difference of means – F-test for comparison of variances, Chi-square test for goodness of fit, Chi-square test for independence.

**Correlation and Regression:** Correlation, lines of regression and examples.

**Text Book(s):**

1. S. C. Gupta and V. K. Kapoor, Fundamentals of Mathematical Statistics, S. Chand & Co, 2006.
2. R. A. Johnson: Miller and Freund's Probability and Statistics for Engineers, Pearson Publishers, 9<sup>th</sup> Edition, 2017 Thomas. G.B, and Finney R.L, Calculus, Pearson Education, 2007.

**References & Web Resources:**

1. S. Milton and J. Arnold, Introduction to Probability and Statistics, Tata McGraw Hill Education Private Limited, 4<sup>th</sup> Edition, 2006.
2. R.K. Jain and S.R.K. Iyenger, Advanced Engineering Mathematics, 2<sup>nd</sup> Edition, Narosa Publishing House. 2005.

Course Title	Course Code	Structure (I-P-C)		
<b>Microprocessors and Microcontrollers</b>	EC251	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Digital Logic Design

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Learn the functional behaviour of a microprocessor using assembly instructions.
<b>CO2</b>	Learn to develop suitable computing architectures for certain applications
<b>CO3</b>	Use microprocessors and microcontrollers for building real time systems
<b>CO4</b>	Understand the data path architecture of microprocessors.
<b>CO5</b>	Understand the ISA of microprocessors and microcontrollers

**Syllabus:**

Evolution of processors. Harvard Versus Von-Neumann, RISC versus CISC, Register File, General Instruction Types, Addressing Modes, and concept of pipelining and parallelism.

Memory: Main memory Technologies (SRAM, DRAM), Cache memory organization, improving cache performance. Input/Output Unit: access of I/O devices, I/O ports, and I/O control mechanisms – Program Controlled I/O. Interrupt controlled I/O and DMA controlled I/O

8086 Architecture, Register Organization, Memory segmentation, Pin configuration, latching of address bus, Buffering of data bus. Minimum and Maximum mode operations.

8086 INTERFACING Memory interfacing: RAM, EPROM IC Chips I/O interfacing: 8255 PPI, 8257 DMA interface interfacing programmable interval timers – 8253/8254

Architecture of 8051, Pin configuration, built-in ROM & RAM organization, Stack organization. Assembly language Programming with 8051: Instruction set, Data transfer, Arithmetic, logical and branching instructions, Addressing modes.

**Text Book(s):**

1. D. A. Patterson and J. L. Hennessy, Computer Organization and Design - ARM, Morgan Kaufmann, 2010..
2. Douglas V Hall, “Microprocessors and Interfacing Programming and Hardware,” 2/e, THM, 2007
3. Mazidi M.A, Mazidi J.G & Rolin D. Mckinlay, “The 8051 Microcontroller & Embedded Systems using Assembly and C,” 2/e, Pearson Education, 2007.

**References & Web Resources:**

1. Morris Mano, M., "Computer System Architecture," 3/e, Pearson Education, 2005.
2. B. B. Brey, Intel Microprocessors, 8th edition, Prentice Hall, 2008.
3. Microprocessors and Microcontrollers by Dr.Santhanuchatopadhy, IIT Kharagpur [https://onlinecourses.nptel.ac.in/noc18\\_ec03/course](https://onlinecourses.nptel.ac.in/noc18_ec03/course)
4. Microprocessors and Microcontrollers, IIT Kanpur. <https://nptel.ac.in/courses/Webcourse-contents/IIT-KANPUR/microcontrollers>

Course Title	Course Code	Structure (I-P-C)		
<b>Analog and Digital Communications</b>	<b>EC252</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Signals and Systems

Course Outcomes: At the end of the course, the students will be able to:

CO1	Understand the basic concepts of signal modulation, demodulation, and transmission.
CO2	Analyze the performance of analog and digital communication systems.
CO3	Design and implement analog and digital communication systems for a given set of specifications.
CO4	Use laboratory equipment and software tools to test and verify the proper operation of communication systems.

**Syllabus:**

Introduction to Analog Communication Systems

- Introduction of Analog Communication Systems
- Modulation Types: Amplitude Modulation (AM), Frequency Modulation (FM), Phase Modulation (PM)
- Properties of Fourier Transform, Band-pass Signals, and their Spectra, Introduction to Mixers, Up-down Converters, and Channel Selection

Analog Communication Techniques

- Amplitude Modulation Techniques: DSB-SC, SSB-SC, VSB
- Frequency Modulation Techniques: Narrowband FM, Wideband FM, Phase Modulation (PM)
- Frequency Division Multiplexing Techniques (FDM), Time Division Multiplexing Techniques (TDM)
- Advanced Modulation techniques: single sideband suppressed carrier (SSBC), vestigial sideband (VSB), orthogonal frequency-division multiplexing (OFDM)

Introduction to Digital Communication:

- Sampling and Quantization, PCM, Delta modulation, Adaptive delta modulation,
- BER Analysis, Bandwidth/Power efficiency, Carrier recovery – squaring and Costas loop.

Digital Communication Principles

- Digital Modulation Techniques: ASK, PSK, FSK, QAM
- Performance Analysis of Digital Communication Systems
- Error Detection and Correction Techniques: Hamming codes, Parity codes, CRC codes, BCH codes
- Introduction to Spread Spectrum Techniques

Communication Systems, Design Challenges:

- Channel Distortions and Noises, Message Sources, Channel Effect,
- Signal-To-Noise Ratio, Information Capacity,
- Modulation and Detection, Matched filter, and correlation receiver, Super heterodyne receiver,

**Text Book(s):**

1. Simon Haykin, An Introduction to Analog and Digital Communications, Wiley Vol 2, 2008.
2. B. P. Lathi and Z. Ding, "Modern Digital and Analog Communication Systems," 4th Edition, Oxford University Press, 2011.

**References & Web Resources:**

1. John G Proakis, Digital Communications, 4th edition, 2008.

Course Title	Course Code	Structure (I-P-C)		
<b>Control Systems</b>	EC254	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Signals and systems

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Model the linear systems using transfer functions and obtain transfer functions using block diagrams and signal flow graphs.
<b>CO2</b>	Understand the significance of time response and find it for system analysis in transient and steady state
<b>CO3</b>	Understand the concept of stability and know different techniques of stability analysis and to introduce the concept of frequency domain analysis, Bode plots, Polar plots
<b>CO4</b>	Understand the concept of state space modeling and analysis.
<b>CO5</b>	Understand the state space model of the systems

**Syllabus:**

Open loop and closed loop systems, Transfer Function models of linear SystemsModelling of Electrical & mechanical Systems, Block Diagram representation of Control Systems – Block Diagram Reduction, Signal Flow Graph Representation of Control Systems, Mason’s gain formula, Feedback Characteristics of Control Systems

Time Response of First and Second Order Systems with Standard Input Signals, Time Domain Specifications of Second Order Systems, Steady State Error, Steady State Error Constants-Basic Control Actions- Effects of Integral and Derivative Control actions.

Concept of Stability, Routh-Hurwitz Criterion, Relative Stability Analysis, The Concept and Construction of Root Loci, Analysis of Control Systems with Root Locus

Frequency Response Bode Plots Log Magnitude versus Phase Plots, Polar Plots Frequency Domain specifications Correlation between Time and Frequency Responses, Stability in Frequency Domain Nyquist Stability Criterion - Assessment of Relative Stability, Gain Margin and Phase Margin.

Concept of state, State Variables and State Models, State space models for LTI electrical Systems, Phase variable form and diagonal canonical form, Conversion between Transfer Function models and State space models, Solution to the State Equation, State Transition Matrix, Concept of Controllability and Observability.

**Text Book(s):**

1. N. S. Nise, “Control Systems Engineering,” Wiley, 2014.Meriam
2. B.C. Kuo, “Automatic Control Systems”, 8th Edition, John Wiley.

**References & Web Resources:**

1. I. J. Nagrath and M. Gopal, “Control System Engineering,” New Age International publishers, 2008.
2. J. J. Distefano, A. R. Stubberud, and I. J. Williams, “Control Systems,” Shaum’s outline Series, 3rd Edition, McGraw Hill.

Course Title	Course Code	Structure (I-P-C)		
<b>Digital Signal Processing</b>	EC253	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Signals and Systems

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Analyze DT signals using DFT along with FFT algorithms
<b>CO2</b>	Analyze discrete time LTI systems, and their impulse responses
<b>CO3</b>	Synthesize discrete signals from analog signals
<b>CO4</b>	Design of FIR type of Digital filters as per the specifications
<b>CO5</b>	Discuss briefly about DSP applications and understand basic concepts of multi rate signal processing.

**Syllabus:**

Review of Discrete-time Signals and Systems: Discrete-time signals: sequences, discrete-time systems, Linear time-invariant (LTI) systems, Properties of LTI systems, Linear constant coefficient difference equations, Frequency domain representation of discrete-time signals and systems, Representation of sequences by Fourier transforms, Symmetry properties of Fourier transform, Fourier transform theorems, Discrete-time random signals.

Transform Analysis of Linear Time Invariant Systems: The frequency response of LTI systems, System functions for systems characterized by linear constant-coefficient difference equations, Frequency response of rational system functions, Relationship between magnitude and phase, All-pass systems, Minimum phase systems.

Fast Fourier Transform: Introduction of the Discrete Fourier Transform (DFT), The Fourier transform of periodic signals, Properties of DFT, Linear convolution using the DFT. Efficient computation of the DFT, The Goertzel algorithms, Radix-2 decimation-in-time and decimation-in-frequency Fast Fourier Transform algorithms.

Structures for Discrete-Time Systems: Block Diagram Representation of Linear Constant-Coefficient Difference Equations, Signal Flow Graph Representation, Direct Forms, Cascade Form.

Filter Design Techniques: Analog filter design, Butterworth, Chebyshev filter technique. FIR filter design using Windowing and frequency sampling techniques. IIR filter design using impulse invariance and bilinear transformation, FIR and IIR filter structures.

Overview of DSP applications, DTMF signal detection, Spectral analysis of sinusoidal signals using FFT, Sub band coding of speech signals, Finite precision arithmetic effects.

**Text Book(s):**

1. A.V. Oppenheim, R.W. Schaffer, and J. R. Buck, "Discrete-Time Signal Processing," Pearson Education, 3<sup>rd</sup> Edition, 2010.

**References & Web Resources:**

1. S. K. Mitra, "Digital Signal Processing: A Computer-Based Approach", 4<sup>th</sup> Edition, Tata Mcgraw Hill Publication, 2013.
2. J. G. Proakis and D. G. Manolakis, "Digital Signal Processing: Principles, Algorithms and Applications", Fourth edition, Pearson, 2007.

Course Title	Course Code	Structure (I-P-C)		
<b>Micro Processors and Microcontrollers Practice</b>	EC255	<b>0</b>	<b>3</b>	<b>2</b>

**Pre-requisite, if any:** Digital logic design

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Program and use microprocessor 8086 for real time applications
<b>CO2</b>	Program and use ARM7 for real time application
<b>CO3</b>	use polar coordinates to describe rotational motion of an object.
<b>CO4</b>	understand the planetary motion and gravitation
<b>CO5</b>	apply the concepts of angular momentum and torque for rigid body dynamics

**Experiments:**

8086 programming : Assembly code for simple addition, simple subtraction, simple multiplication, division, multiply accumulation, matrix addition/subtraction/multiplication, finding the odd-even, addition of N numbers, convolution, find the largest of N numbers, and so on. Accessing the peripherals (Switches, LEDs, Keypad, seven segment display, buzzer, relay, ADC, and temperature sensor) of 8086 development boards. Real time applications (traffic light control, stepper motor control, logic control, and so on) using 8086 and 8051 development boards.

ARM7 programming : Accessing the peripherals (Switches, LEDs, Keypad, seven segment display, buzzer, relay, ADC, and temperature sensor) of ARM7-LPC2148 development board, Assembly code for simple addition, simple subtraction, simple multiplication, division, multiply accumulation, matrix addition/subtraction/multiplication, finding the odd-even, addition of N numbers, convolution, find the largest of N numbers, and so on.

Project Work (Individual or 2-per group with respect to the availability of boards): Any project work using the programming skills obtained from the aforementioned topics with 8086 or ARM7 development boards. The title and objective of the projects will be chosen or formed by the students.

**Text Book(s):**

1. S. Furber, ARM System-on-chip Architecture, 13th impression, Pearson, 2012.
2. Kenneth J. Ayala, The 8086 Microprocessor: Programming and Interfacing The PC, Delmar Publishers, 2007

**References & Web Resources:**

1. A. K. Ray, K. M. Bhurchandi, Advanced Microprocessors and Peripherals, TMH, 2007.

Course Title	Course Code	Structure (I-P-C)		
<b>Analog and Digital Communications Practice</b>	EC256	<b>0</b>	<b>3</b>	<b>2</b>

**Pre-requisite, if any:** Signals and systems

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Ability to analyze and design analog communication systems such as amplitude modulation, frequency modulation, and pulse modulation.
<b>CO2</b>	Ability to analyze and design digital communication systems such as pulse code modulation, delta modulation, and PCM encoding and decoding.
<b>CO3</b>	Ability to demonstrate the use of various communication test and measurement tools such as oscilloscopes, signal generators, and spectrum analyzers.
<b>CO4</b>	Ability to work effectively as part of a team to design and implement a communication system.
<b>CO5</b>	Ability to identify and solve communication system problems through experimentation and troubleshooting techniques.

**Experiments:**

1. (i) Amplitude modulation and demodulation (ii) Spectrum analysis of AM
2. (i) Frequency modulation and demodulation (ii) Spectrum analysis of FM
3. DSB-SC Modulator & Detector
4. SSB-SC Modulator & Detector (Phase Shift Method)
5. Frequency Division Multiplexing & De multiplexing
6. Pulse Amplitude Modulation & Demodulation
7. Pulse Width Modulation & Demodulation
8. Pulse Position Modulation & Demodulation
9. PCM Generation and Detection
10. Delta Modulation
11. Frequency Shift Keying: Generation and Detection
12. Binary Phase Shift Keying: Generation and Detection
13. Generation and Detection (i) DPSK (ii) QPSK

**Text Book(s):**

1. B. P. Lathi and Z. Ding, "Modern Digital and Analog Communication Systems," 4th Edition, Oxford University Press, 2011.
2. S. Haykin, "Communication Systems," 4th Edition, Wiley, 2006

**References & Web Resources:**

1. J. M. Wozencraft and I. M. Jacobs, "Principles of Communication Engineering," Wiley, 1965.
2. J. R. Barry, E. A. Lee, and D. G. Messerschmitt, "Digital Communication," 3rd Edition, Springer, 2004.



Course Title	Course Code	Structure (I-P-C)		
<b>Digital Signal Processing Practice</b>	EC257	<b>0</b>	<b>3</b>	<b>2</b>

**Pre-requisite, if any:** Signals and Systems

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand various properties of signals and systems
<b>CO2</b>	Apply various operations (filtering) on signals
<b>CO3</b>	Become aware of various applications of Signal Processing
<b>CO4</b>	Analyze DFT, DTFT, and FFT on discrete signals.
<b>CO5</b>	Design digital filters.

**Syllabus:**

1. Convolution of discrete signals
2. Auto and cross correlation of discrete signals
3. Verification of the properties of convolution and correlation
4. Implementation of DFS, DFT, and DTFT
5. Implementation of DIT-FFT and DIF-FFT algorithms
6. Verification of the properties of DFS, DFT, DTFT, and FFT
7. FIR filter design
8. Analysis of FIR filter with various windowing techniques
9. IIR filter design
10. Analysis of IIT filter design with various analog approximations
11. Read and write audio, image, and video signals
12. Analysis of differences between the mono audio, stereo audio, binary image, grey image, colour image, grey video, and colour video.

**Text Book(s):**

1. S. K. Mitra, "Digital Signal Processing: A Computer-Based Approach", Fourth edition, Tata Mcgraw Hill Publication, 2013.
2. E. Ifeachor, B. W. Jervis, "Digital Signal Processing: A Practical Approach" Second edition, Pearson, 2002.

**References & Web Resources:**

1. S. W. Smith, "Digital Signal Processing: A Practical Guide for Engineers and Scientists", 3<sup>rd</sup> Edition, Newnes (an imprint of Butterworth-Heinemann Ltd.), 2002.
2. Manuals of TI TMS320C67XX DSP Starter Kit.
3. A.V. Oppenheim, R.W. Schaffer, and J. R. Buck, "Discrete-Time Signal Processing," Pearson Education, 3<sup>rd</sup> Edition, 2010.

Course Title	Course Code	Structure (I-P-C)		
<b>Wireless Communication</b>	EC301	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Signals and Systems, Analog and Digital Communication Techniques

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Explain fundamental theories and concepts of modern wireless communication systems.
<b>CO2</b>	Design a wireless communication system using digital modulation techniques.
<b>CO3</b>	Select and implement protocols for wireless networks such as WLAN, WMAN, and WPAN.
<b>CO4</b>	Evaluate the potential of the next generation of wireless communication systems.
<b>CO5</b>	Analyze and solve problems in wireless communication networks

### Syllabus:

Wireless Communication Overview, the Wireless Channel: Fading, Large scale fading, small scale fading, Physical modeling for wireless channels, different statistical channel models. Channel parameters: Time and Frequency coherence, delay spread, power profile, Capacity of wireless Channel- Capacity of Flat Fading Channel, Channel State Information, Capacity with Receiver diversity – Capacity comparisons – Capacity of Frequency Selective Fading channels, Jakes model for wireless channel correlation.

Overview of communication system design, Analog vs Digital and Single vs Multi-user communication, RF Circuits and Propagation: RF circuits and components, Propagation models and channels, Antennas and radiation patterns, Digital Modulation Techniques: Analog to digital conversion, Digital modulation techniques, Spread spectrum techniques.

Introduction to Cellular and Mobile communications, the cellular and mobile concept and system design fundamentals. Frequency reuse, Channel assignment strategies, Handoff strategies, Interference and system capacity, Trunk and grade services, Methods for improving coverage and capacity in cellular systems, Multiple access techniques TDMA, CDMA, FDMA and SDMA.

WLANs: IEEE 802.11 standards, WLAN architecture, Medium access control protocols, Wireless Personal Area Networks (WPANs): IEEE 802.15 standards, ZigBee and Bluetooth, standards, Protocols for WPANs

Wireless Metropolitan Networks (WMANs): IEEE 802.16 standards, WiMaxarchitecture, Medium access control protocols, Wireless Sensor Networks (WSNs): Introduction to WSNs, Types and architectures of WSNs, Protocols for WSNs

4G and 5G wireless systems: The evolution of wireless communication systems, Comparison between 4G and 5G wireless systems, Applications of 5G wireless systems

Wireless Network Security: Network and Information Security, Threats and Attacks on Wireless Networks, Security Solutions for Wireless Networks

### Textbook(s):

1. Andrea Goldsmith, Wireless Communication, Cambridge University Press.
2. Aditya Jagannatham, Principles of Modern Wireless Communication Systems, McGraw Hill, (2016)

### References & Web Resources:

1. Theodore Rappaport, Wireless Communications, principles and Practices, 2nd Edition, Pearson.

Course Title	Course Code	Structure (I-P-C)		
<b>Electronic Manufacturing and Prototyping</b>	EC302	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Analog and Digital Electronics

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the Overview of electronic systems manufacturing and packaging
<b>CO2</b>	Discover Design Considerations for Different Types of PCB
<b>CO3</b>	Understand to design PCB using CAD Tool
<b>CO4</b>	Analyze PCB design Rules
<b>CO5</b>	Select Appropriate technique to test PCB

**Syllabus:**

Overview of electronic systems manufacturing and packaging, Introduction to IC manufacturing and realization of passive components in ICs and VLSI, Surface Mount Technology, Thermal budget and Current trends

Design Considerations for Different Types of PCBs: Single Layer PCB, Multilayer PCB, Flexible PCB, etc. Design Considerations for PCBs for Different Applications: Digital Circuits, Analog Circuits, High-Speed Circuits, Power Circuits, etc

Introduction to PCB Design using PCB tool Introduction to PCBs and general guidelines, PCB design rules for various applications. Creation of new project in PCB tool, drawing the circuit in the schematic page using the components from the library. Simulation of Circuit using P-spice Simulation for verification of results, adding footprints to the components from the library. Creating the netlist, importing the components on PCB tool PCB Editor. Placing and moving the components in PCB Editor as per design sequence, Routing between the components. Generating pdf files and Gerber files

Layout Rules and Parameters. Design Rule Checks: Signal Layer Checks, Power / Ground Checks, Solder Mask Check, Drill Check, etc. Automated Processes, Through Hole Vs. SMT Technologies. Thermal Management for IC and PCBs, Cooling Requirements, Electronic Cooling Methods

Functions of an Electronic Package: Packaging Hierarchy, Driving Forces on Packaging Technology, Materials for Microelectronic Packaging, Material for High-Density Interconnect Substrates, Electrical Anatomy of Systems Packaging, Signal Distribution, Power Distribution, Electromagnetic Interference, Design Process.

Symptom Recognition, Bracketing Technique, Component failure Analysis, Fault types and causes in circuits, during manufacturing, Manual trouble shooting technique Tools and Instruments DMM CRO, PCO, Logic probes, Logic pulsar, Logic Analyzer.

**Textbooks:**

1. R. T. Rao, Fundamentals of Microsystems Packaging, McGraw Hill, 2001, ISBN- 10: 0071371699, ISBN-13: 978-0071371698. 2. J. Axelson, Making Printed Circuit Boards, TAB/McGraw Hill, 1993, ISBN- 10: 0070027994, ISBN-13: 978-0070027992.
2. J. Axelson, Making Printed Circuit Boards, TAB/McGraw Hill, 1993, ISBN- 10: 0070027994, ISBN-13: 978-0070027992.

**References:**

1. . R. K. Ulrich, W. D. Brown, Advanced Electronic Packaging, : IEEE Press Series on Microelectronic Systems, 2 nd edition, 2006, Wiley-IEEE Press; ISBN-10: 0471754501, ISBN-13: 978-0471754503
2. J. Varteresian, Fabricating Printed Circuit Boards (Demystifying Technology) 1 st edition, Newnes, 2002. ISBN-10: 1878707507, ISBN-13: 978-1878707505

3. R. A. Reis, Electronic project design and fabrication, 6 th edition, Prentice Hall, 2004, ISBN-10: 0131130544, ISBN-13: 978-0131130548
4. K. Mitzner Complete PCB Design Using OrCad Capture and Layout, Elsevier, 2009, ISBN :9780750689717.
5. J. H. Lau, C. P. Wong, J. L. Prince, Electronic Packaging: Design, Materials, Process, and Reliability Electronic Packaging and Interconnection Series, 1 st edition, McGraw- Hill Professional, 1998. ISBN-10: 0070371350, ISBN-13: 978-0070371354

Course Title	Course Code	Structure (I-P-C)		
<b>Data Communication and Networking</b>	EC304	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Computer Networks, C Programming

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand a transmission of a data in a network
<b>CO2</b>	Acquire knowledge of various OSI layers.
<b>CO3</b>	Understand topologies for specific networks.
<b>CO4</b>	Understand the basics of cryptography.
<b>CO5</b>	Understand various protocols of wireless transmission

**Syllabus:**

Overview of Data Communication and Networking: Introduction; Data communications: components, data representation (ASCII, ISO etc.), direction of data flow (simplex, half duplex, full duplex); network criteria, physical structure (type of connection, topology), categories of network (LAN, MAN, WAN); Internet: brief history, Protocols and standards; Reference models: OSI reference model, TCP/IP reference model, their comparative study.

Physical Layer: Overview of data (analog& digital), signal (analog& digital), transmission (analog& digital) & transmission media (guided & unguided); Circuit switching: time division & space division switch, TDM bus; Telephone Network; ATM, B-ISDN.

Data link Layer: Types of errors, framing (character and bit stuffing), error detection & correction methods; Flow control; Protocols: Stop & wait ARQ, Go-Back- N ARQ, Selective repeat ARQ, HDLC.

Medium Access sub layer: Point to Point Protocol, LCP, NCP, Token Ring; Reservation, Polling, Multiple access protocols: Pure ALOHA, Slotted ALOHA, CSMA, CSMA/CD, CSMA/CA Traditional Ethernet, fast Ethernet (in brief).

Network layer: Internetworking & devices: Repeaters, Hubs, Bridges, Switches, Router, Gateway; Addressing: IP addressing, subnetting; Routing: techniques, static vs. dynamic routing, Unicast Routing Protocols: RIP, OSPF, BGP; Other Protocols: ARP, IP, ICMP, IPV6.

Transport layer: Process to Process delivery; UDP; TCP; Congestion Control: Open Loop, Closed Loop choke packets; Quality of service: techniques to improve QoS: Leaky bucket algorithm, Token bucket algorithm.

Application Layer: Introduction to DNS, SMTP, SNMP, FTP, HTTP & WWW; Security: Cryptography (Public, Private Key based), Digital Signature, Firewalls.

**Text Book(s):**

1. B. A. Forouzan, Data Communications and Networking, 4<sup>th</sup> edition, Tata McGraw Hill 2012, ISBN: 0072967757
2. A. S. Tanenbaum, Computer Networks, 4<sup>th</sup> edition, Pearson, 2013, ISBN: 978-0132126953

**References & Web Resources:**

1. W. Stallings, Data and Computer Communications, 5th edition, Pearson, 5th edition, 2013, ISBN: 978-0133506488.

Course Title	Course Code	Structure (I-P-C)		
<b>VLSI System Design</b>	EC303	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Digital Logic Design

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Design the digital systems using Verilog or VHDL
<b>CO2</b>	Estimate the circuit/system performance, area, and power dissipation
<b>CO3</b>	Implement the low power and high throughput techniques on digital VLSI circuits.
<b>CO4</b>	Develop the Custom IPs to integrate into Digital Systems using EDA..
<b>CO5</b>	Understand the CMOS digital circuits.

**Syllabus:**

Introduction to VLSI Design, Need for VLSI Design, Various VLSI design flows, Basic classifications of VLSI design. Digital Arithmetic Circuits, Fixed Point/Floating Point/Galois Field Arithmetic, RTL Design using Verilog HDL. Introduction to Hardware-Software Co-design, Custom IPs, High level synthesis, and formal hardware verification.

MOS Transistors, Operation of MOSFET, CMOS Logic - Inverter, Logic Gates, Pass Transistors and Transmission Gates, Tri states, Multiplexers, Sequential Circuits, and Pass Transistor Logic .

CMOS Fabrication and Layout - Inverter Cross-section, Fabrication process, Layout Design Rules, Gate Layouts, Stick Diagrams. Timing optimization, Transient response, RC Delay Model, Linear Delay Model, Logical Effort of Paths. Statistical timing analysis.

Sources of Power Dissipation, Dynamic Power, Static Power, Energy-Delay Optimization, Low Power Architectures. Testers, test fixtures, and Test Programs, BIST, Scan Chains, Design for Testability, Fault tolerant designs. CMOS chip design options: Full custom ASICs, Std. Cell based ASICs, Gate Array based ASICs, Programmable logic structures-PLA, PAL, PROM, FPGA. Introduction to Physical Design: Floor plan, power plan, placement, routing, physical verification.

**Text Book(s):**

1. Weste and Eshraghian: Principles of CMOS VLSI design, Addison Wesley, 4th Edn, 2011.
2. Samir Palnitkar: Verilog HDL - Guide to Digital design and synthesis, Pearson Education, 3rd Edn, 2003

**References & Web Resources:**

1. CMOS Logic Circuit Design, John P Uyemura, 2009, Springer
2. Verilog for Digital Design, Frank Vahid, Roman Lysecky, Wiely, 2007

Course Title	Course Code	Structure (I-P-C)		
<b>Wireless Communication Practice</b>	EC305	<b>0</b>	<b>3</b>	<b>2</b>

**Pre-requisite, if any:** Signals and Systems, Analog and Digital Communication Techniques

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understanding of Wireless Communication system in detail with its concepts, techniques and application usage Practice.
<b>CO2</b>	This course Simulation basics of Wireless transmission, Channel Modelling, link budget calculations, Capacity and Fading.
<b>CO3</b>	Every topic in Wireless communication to be explained with its function either with demonstration and/or simulation using suitable software.
<b>CO4</b>	Upon completion of this course, students will be able to understand the principles of wireless communication and its applications.
<b>CO5</b>	Students will be able to design, conduct and evaluate experiments related to wireless communication.

**Experiments:**

Experiment-1: Basic experiments in Wireless Communication

- 1. Antenna, Antenna Polarization and Antenna measurements
- 2. Signal transmission and reception measurements
- 3. Signal propagation and interference measurements

Experiment-2: Introduction to Wireless Communication Systems

- Definition and scope of Wireless Communication
- Wireless Communication Systems and Techniques
- Differences between Wired and Wireless Communication Systems
- Advantages and Disadvantages of Wireless Communication

Experiment-3: Wireless Communication Standards and Protocols

- Overview of Wireless Communication Standards and Protocols
- GSM, CDMA and LTE standards
- WiFi and Bluetooth Protocols

Experiment-4: Signal Propagation and Channel Modeling

- Understanding Signal Propagation
- Link Budget Calculations
- Types of Channel Models

Experiment -5: Wireless Communication System Design

- System Design Methodology
- Frequency Allocation and Spectrum utilization
- Antenna System Design Principles
- Power Management

Experiment-6: Practical Aspects of Wireless Communication

- Wireless Communication Testing and Measurements
- Troubleshooting Wireless Communication Systems
- Security issues in Wireless Communication
- Wireless Communication Applications

Experiment-7: Final Project

- Students will work on a final project related to wireless communication.
- They will have to design, conduct and report the results of their project.
- Students will have to present their project to the class.

**Text Book(s):**

1. Andrea Goldsmith, Wireless Communication, Cambridge University Press.
2. Aditya Jagannatham, Principles of Modern Wireless Communication Systems, McGraw Hill, (2016)

**References & Web Resources:**

1. Theodore Rappaport, Wireless Communications, principles and Practices, 2nd Edition, Pearson.163



Course Title	Course Code	Structure (I-P-C)		
<b>Electronic Manufacturing and Prototyping Practice</b>	EC306	0	3	2

**Pre-requisite, if any:** Analog and Digital Electronics

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the Flow of PCB Designing Process
<b>CO2</b>	Discover Designing different types of PCB
<b>CO3</b>	Practice designing PCB using CAD Tool
<b>CO4</b>	Examine fabricated PCB
<b>CO5</b>	Design and fabrication of PCB for different applications

**Tool:** Open-Source Tools

### Experiments:

1. Designing PCB for different Power Supply Circuits
2. Regulator Circuit Design using IC 723, IC78XX, and IC79XX, Designing of power supplies
3. Switching power Supply, DC to DC Converter, Buck Converter, Boost Converter, and Buck- Boost Converter
4. Designing of Analog circuits
5. Signal Conditioning circuit, Current Source, V to I circuits
6. Designing Analog and Digital Circuits
7. Designing with Microcontroller
8. Mini Project- Fabrication of PCB using Printing, Milling, and Etching Methods

### Textbooks:

1. R. T. Rao, Fundamentals of Microsystems Packaging, McGraw Hill, 2001, ISBN- 10: 0071371699, ISBN-13: 978-0071371698. 2. J. Axelson, Making Printed Circuit Boards, TAB/McGraw Hill, 1993, ISBN- 10: 0070027994, ISBN-13: 978-0070027992.
2. J. Axelson, Making Printed Circuit Boards, TAB/McGraw Hill, 1993, ISBN- 10: 0070027994, ISBN-13: 978-0070027992.

### References:

1. R. K. Ulrich, W. D. Brown, Advanced Electronic Packaging, : IEEE Press Series on Microelectronic Systems, 2 nd edition, 2006, Wiley-IEEE Press; ISBN-10: 0471754501, ISBN-13: 978-0471754503
2. J. Varteresian, Fabricating Printed Circuit Boards (Demystifying Technology) 1 st edition, Newnes, 2002. ISBN-10: 1878707507, ISBN-13: 978-1878707505
3. R. A. Reis, Electronic project design and fabrication, 6 th edition, Prentice Hall, 2004, ISBN-10: 0131130544, ISBN-13: 978-0131130548
4. K. Mitzner Complete PCB Design Using OrCad Capture and Layout, Elsevier, 2009, ISBN :9780750689717.
5. J. H. Lau, C. P. Wong, J. L. Prince, Electronic Packaging: Design, Materials, Process, and Reliability Electronic Packaging and Interconnection Series, 1 st edition, McGraw- Hill Professional, 1998. ISBN-10: 0070371350, ISBN-13: 978-0070371354

Course Title	Course Code	Structure (I-P-C)		
<b>VLSI system design Practice</b>	EC307	<b>0</b>	<b>3</b>	<b>2</b>

**Pre-requisite, if any:** Digital Logic Design

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Demonstrate the knowledge of digital circuit design flow
<b>CO2</b>	Analyse the process of simulation of combinational sequential circuits
<b>CO3</b>	Validate and demonstrate the results of digital circuits
<b>CO4</b>	Design of CMOS digital circuits
<b>CO5</b>	Implementation of digital circuits using FPGA

**Experiments:**

1. Simulate the parameters of NMOS, PMOS transistors from its characteristics.
2. Design and simulate the Symmetrical CMOS inverter.
3. Simulate and compare the performance of CMOS inverter over NMOS inverter.
4. Design and simulate the two input CMOS NAND/NOR gate.
5. Design and simulate the 4-bit CMOS adder Design and simulate Carry bypass adder.
6. Design and simulate the D-Flip Flop using transmission gates
7. Simulate the static and dynamic SRAM cells.
8. Layout design of CMOS inverter
9. Design and synthesis of digital CMOS circuits using EDA tool.
10. Implementation of digital circuits using FPGA
11. Implementation of digital circuits with semi custom ASIC

**Text Book(s):**

1. Weste and Eshraghian: Principles of CMOS VLSI design, Addison Wesley, 4th Edn, 2011.

**References & Web Resources:**

1. CMOS Logic Circuit Design, John P Uyemura, 2009, Springer

Course Title	Course Code	Structure (I-P-C)		
<b>Antenna and Microwave Circuits Design</b>	EC351	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Electromagnetic waves and Transmission Lines

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Analyse various passive and active microwave circuits
<b>CO2</b>	Analyse a given antenna and find out its fundamental parameters.
<b>CO3</b>	Plan the link budget for microwave systems
<b>CO4</b>	Design Antennas with the given specification
<b>CO5</b>	Design microwave components like a filter, coupler, amplifier, mixer, oscillator and LNA.

**Syllabus:**

Microwave Network Analysis: Impedance and Equivalent Voltages and Currents, Impedance and Admittance Matrices, Reciprocal Networks, Lossless Networks, The Scattering Matrix, and The Transmission (ABCD) Matrix.

Microwave Passive Circuits: Power dividers and directional couplers, microwave filters, Noise and nonlinear distortion.

Microwave Active Circuits: Active RF and Microwave Devices, amplifier design, oscillators and mixers.

Microwave Systems: Link Budget and Link Margin of wireless communication systems, Radio Receiver Architectures, Noise Characterization of a Receiver.

Types of Antennas, Radiation Mechanism of Antenna, Fundamental Parameters and Figures-of-Merit of Antennas Radiation Integrals and Auxiliary Potential Functions.

Linear Wire Antennas, Loop Antennas, Microstrip and Mobile Communications Antennas, Array antennas.

Antenna Synthesis and Continuous Sources, Integral Equations, Moment Method, and Self and Mutual Impedances.

**Text Book(s):**

1. Pozar, David M. Microwave engineering. John wiley& sons, 2011.
2. Balanis, Constantine A. Antenna theory: analysis and design. John wiley& sons, 2015.

**References & Web Resources:**

1. Stutzman, Warren L., and Gary A. Thiele. Antenna theory and design. John Wiley & Sons, 2012.
2. Collin, Robert E. Foundations for microwave engineering. John Wiley & Sons, 2007.

Course Title	Course Code	Structure (I-P-C)		
Information Theory and Coding	EC352	3	0	3

**Pre-requisite, if any:**

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Analyze different sources in terms of entropy
<b>CO2</b>	Analyze different channels in terms of mutual information
<b>CO3</b>	Design data compression for various sources
<b>CO4</b>	Compute the capacity of different channels
<b>CO5</b>	Analyze AWGN channels

### Syllabus

Information - Fundamentals: Entropy, joint entropy and conditional entropy, relative entropy and mutual information, chain rules for entropy, relative entropy, and mutual information, Jensen's inequality, log sum inequality, sufficient statistics, Fano's inequality

Asymptotic Equipartition Property (AEP): AEP, consequence of AEP - data compression, typical set.

Data Compression: Kraft inequality, optimal codes and bounds on optimal codelength, Kraft inequality for uniquely decodable codes, Huffman codes, Shannon-Fano-Elias coding (

Channel Capacity: (Binary) Symmetric Channels, Jointly typical sequences, the channel coding theorem, Fano's inequality and the converse to the coding theorem, Hamming codes, joint source-channel coding theorem.

Gaussian Channel: Differential entropy, coding theorem for Gaussian channels

### Textbooks

1. T. M. Cover and J. A. Thomas, Elements of Information Theory, 2nd edition, John-Wiley & Sons, 2006. ISBN: 978-0471241959

### References & Web Resources:

1. I. Csiszar and J. Korner, Information Theory: Coding Theorems for Discrete Memoryless Systems, 1st edition, Akademiai Kiado, 1997. ISBN: 978-9630574402

2. R. G. Gallager, Information Theory and Reliable Communication, 1st edition, Wiley, 1968, ISBN: 978-0471290483

Course Title	Course Code	Structure (I-P-C)		
<b>Antenna and Microwave Circuits Design Practice</b>	EC353	<b>0</b>	<b>3</b>	<b>2</b>

**Pre-requisite, if any:** Electromagnetic waves and Transmission Lines

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Measure of the fundamental parameters of the given antennas
<b>CO2</b>	Measure the s-parameters of various microwave circuits
<b>CO3</b>	Design various antennas using computational softwares, fabricate and measure their performance.
<b>CO4</b>	Design various microwave passive components like filters, couplers using computational softwares, fabricate and measure their s-parameters..
<b>CO5</b>	Design various microwave active components like amplifier, mixer, oscillator and LNA using computational softwares.

**Experiments:**

1. Measure the fundamental parameters of various antennas like dipole, horn, and microstrip antennas.
2. Measure the s-parameters of various couplers, filters, and Amplifiers.
3. Design wireless antenna for 4G and 5G applications, fabricate, and test its performance.
4. Design microwave passive components, fabricate, and test.
5. Design a microwave active component.

**Text Book(s):**

1. Pozar, David M. Microwave engineering. John wiley& sons, 2011.
2. Balanis, Constantine A. Antenna theory: analysis and design. John wiley& sons, 2015.

**References & Web Resources:**

1. Stutzman, Warren L., and Gary A. Thiele. Antenna theory and design. John Wiley & Sons, 2012.
2. Collin, Robert E. Foundations for microwave engineering. John Wiley & Sons, 2007.

Course Title	Course Code	Structure (I-P-C)		
Information Theory and Coding Practice	EC354	0	3	2

**Pre-requisite, if any: Information Theory and Coding**

**Course Outcomes:** At the end of the course, the students will be able to:

CO1	To understand the programming of Entropies and Mutual Information
CO2	To understand the programming of Entropies and Mutual Information
CO3	To develop MATLAB codes for Block codes, Cyclic codes and Convolutional codes.
CO4	Analysis of Differential entropy, coding theorem for Gaussian channels
CO5	Analyze AWGN channels with practical knowledge

List of Experiments

1. Write a program for determination of various entropies and mutual information of a given channel.
2. Write a program for generation and evaluation of variable length source coding using C/MATLAB a) Shannon – Fano coding and decoding b) Huffman Coding and decoding c) Lempel Ziv Coding and decoding
3. Write a Program for coding & decoding of Linear block codes.
4. Write a Program for coding & decoding of Cyclic codes.
5. Write a program for coding and decoding of convolutional codes.
6. Write a program for coding and decoding of BCH and RS codes.
7. Write a simulation program to implement source coding and channel coding for transmitting a text file.

**Textbooks**

1. T. M. Cover and J. A. Thomas, Elements of Information Theory, 2nd edition, John-Wiley & Sons, 2006. ISBN: 978-0471241959

**References & Web Resources:**

1. I. Csiszar and J. Korner, Information Theory: Coding Theorems for Discrete Memoryless Systems, 1st edition, Akademiai Kiado, 1997. ISBN: 978-9630574402
2. R. G. Gallager, Information Theory and Reliable Communication, 1st edition, Wiley, 1968, ISBN: 978-0471290483

Course Title	Course Code	Structure (I-P-C)		
<b>MOSFET Modelling for VLSI Circuits</b>	EC501	<b>3</b>	<b>2</b>	<b>4</b>

**Pre-requisite, if any:** Electronic Devices and Circuits

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Model any kind of MOS Devices in 2-D or 3-D
<b>CO2</b>	Relate the models for further inclusion in circuits
<b>CO3</b>	Develop solution to overcome short channel issues
<b>CO4</b>	Develop various compact models appropriate for industry
<b>CO5</b>	Analyse the frequency response of MOS devices.

**Syllabus:**

**Theory:**

1. Intuitive analysis of MOS Transistor- Two-Terminal MOS Structure – Flatband Voltage, Surface Condition, General Analysis, Inversion, Strong Inversion, Weak Inversion, Small- Signal Capacitance, Three-Terminal MOS Structure (7 hours)
2. Long-Channel MOS Transistor, Introduction All-Region Models, Strong Inversion Models, Weak Inversion Models, Source Reference vs. Body Reference, Effective Mobility (5 hours)
3. Small-Dimension Effects - Velocity Saturation, Channel Length Modulation, Charge Sharing, Drain-Induced Barrier Lowering, Hot Carrier Effects, Velocity Overshoot Ballistic Operation, Polysilicon Depletion (6 hours)
4. Small-Dimension Effects-Modelling for Circuits Simulation- Quantum-Mechanical Effects; Gate Current, Junction Leakage, Scaling and New Technologies, Approaches, and Properties of Good Models, Model Formulation Considerations, Parameter Extraction, Compact Models, Benchmark Tests (7 hours)
5. Small-Signal Modelling - Conductance Parameter Definitions and Equivalent Circuits, Conductance Parameters Due to Gate and Body Leakage, Transconductance, Source-Drain and Output Conductance, Capacitance Definitions and Equivalent Circuits, Capacitance Evaluation and Properties, y-Parameter Model, RF Models (11 hours)

**Practice:**

- Introduction to Technology computer aided design (TCAD) tools; inputs and outputs of device and process simulations. (8 hours)
2. Device simulation: observing the terminal characteristics and distributions of carriers, current, field, potential and energy band diagrams within the device. (8 hours)
  3. Process simulation: observation of device structure and doping profile Simulation of 2-D MOSFETs through device and process simulations (8 hours)
  4. Simulation of novel 3-D transistors such as III-V HEMT, LEDs, FinFETs, GAA devices, solar cells etc, through device simulation (8 hours)
  5. DC, AC, RF mixed mode and noise simulation for the devices (8 hours)

**Text Book(s):**

1. Y. Tsividis and C. McAndrew, "MOSFET modelling for Circuit Simulation", Oxford University Press, 2011
2. C K Maiti, "Introducing Technology Computer-Aided Design (TCAD): Fundamentals, Simulations, and Applications", Jenny Stanford Publishing; 1st Edition, 2017, ISBN: 978-9814745512.
3. Wu, Yung-Chun, Jhan, Yi-Ruei, "3D TCAD Simulation for CMOS Nanoelectronic Devices", Springer, 2017, ISBN 978-981-10-3066-6

**References & Web Resources:**

1. T. A. Fjeldly, T. Yetterdal, and M. Shur, "Introduction to Device Modeling and Circuit Simulation", John Wiley, 1998.
2. Y. Taur and T. H. Ning, "Fundamentals of Modern VLSI Devices", Cambridge University Press, 1998.
3. Y. P. Tsividis, "Mixed Analog-digital VLSI Devices and Technology", World Scientific Publishing Co Pte Ltd, 2002
4. C K Sarkar, "Technology Computer Aided Design: Simulation for VLSI MOSFET", CRC Press, 1st Edition, 2013, ISBN: 978-1466512658.
5. J.-P. Colinge, "FinFETs and Other Multi-Gate Transistors", Springer, 2008, ISBN: 978- 0-387-71751-7



Course Title	Course Code	Structure (I-P-C)		
<b>Digital VLSI System Design</b>	EC502	<b>3</b>	<b>2</b>	<b>4</b>

**Pre-requisite, if any:** Digital Logic Design, VLSI Design

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Design digital systems using HDL and CMOS transistors.
<b>CO2</b>	Analyse the circuit/system performance, area, and power dissipation
<b>CO3</b>	Implement the low power and high throughput techniques on digital integrated circuits
<b>CO4</b>	Develop the Custom IPs to integrate into Digital Systems
<b>CO5</b>	Design the RTL based digital circuits using HDL.
<b>CO6</b>	Develop the hardware-software co-design using VLSI CAD tool.

**Syllabus:**

**Theory:**

1. Introduction to Digital design: timing issues, pipelining, folding/unfolding, resource sharing, metastability, synchronization, clock skew, setup/hold time of flip-flops, synchronization between multiple clock domains using FIFO, PLL, and DLL, reset – recovery/removal time, false path. (5 hours)
2. Digital Systems Design with ASICs: PLDs, Semi/full custom ASIC designs, Emphasis on the synthesis based approach to VLSI Design. Relevant issues related to physical design automation such as partitioning, floor planning, power planning, placement & routing, Algorithms for VLSI Physical Design, IO pads, electro static discharge. (10 hours)
3. Digital Systems Design with FPGAs: Hardware-Software Co-design, Custom IP Development, High level synthesis (HLS), Efficient Coding Techniques in High Level Language for HLS, Partial Reconfiguration. (5 hours)
4. CMOS Transistor Logic: I-V characteristics, Short channel effects, Mobility degradation & velocity saturation, channel length modulation, body effect, drain induced barrier lowering, leakage, RC delay model, logical effort, clock gating, dynamic voltage scaling, power gating, glitch free circuits, dual-edge triggering, static CMOS, ratioed circuits, dynamic CMOS, domino logic, pass transistor logic, (10 hours)
5. CMOS Synchronous Circuits: CMOS latches, CMOS flip flops, dual edge triggered flip flops, synchronizers, arbiters, wave pipelining. (5 hours)
6. Memory Designs: SRAM, DRAM, ROM, PROM, EPROM, EEPROM, Flash, CAM (5 hours)

**Practice:**

1. Introduction to RTL Design: Basic combinational (half adder, full adder, multiplexer, decoder, and so on) and sequential circuits design (Flip-flops and counters) using HDL with commercial VLSI CAD tools or open source compilers. (5 hours)
2. Familiarity of Datapath elements: 32-bit Ripple carry adder, recursive doubling based carry look ahead adder, Braun multiplier, Wallace tree multiplier, non restoring based division, IEEE-754 floating point adder/Subtractor/multiplier/divider, CORDIC, modular multiplier, modular

multiplicative inverse, modular exponentiation, cross-bar switch, Banyan switch, Batcher switch, digital FIR filter. (10 hours)

3. Advanced VLSI circuit design concepts: Pipelining, clock gating to reduce the switching power dissipation, hardware reuse strategy (folded hardware) to reduce the area, fault tolerant digital circuit design, formal hardware verification using equivalence check, high level synthesis with EDA, performance analysis of RTL design & high level synthesis based digital system using EDA, partial reconfiguration using EDA. (5 hours)

4. Hardware-Software Co-design: Design flow of hardware-software co-design using FPGA evaluation board with EDA, Custom IP design (arithmetic circuits as mentioned above), hardware-software partitioning, and performance analysis of various hardware-software co-design techniques. (10 hours)

5. Digital Circuits Design using CMOS: logic gates, combinational logic circuits, low power CMOS circuits using VLSI CAD tool. (10 hours)

**Text Book(s):**

1. Neil H.E. Weste and David Money Harris, "CMOS VLSI Design: A Circuits and Systems Perspective", Addison Wesley, 4th Edn, 2011.

**References & Web Resources:**

1. Wakerly, J. F., "Digital Design: Principles and Practices", 4th Edition, Pearson, 2008
2. Miron Abramovici, Melvin A Breuer, and Arthur D Friedman, "Digital Systems Testing and Testable Designs", Wiley-IEEE Press, 1994.
3. N. A. Sherwani, "Algorithms for VLSI Physical Design Automation", Bsp Books Pvt. Ltd., 3rd edition, 2005.
4. Samir Palnitkar, "Verilog HDL - Guide to Digital design and synthesis", Pearson Education, 3rd Edn, 2003.

Course Title	Course Code	Structure (I-P-C)		
<b>Embedded System Design</b>	EC503	<b>3</b>	<b>2</b>	<b>4</b>

**Pre-requisite, if any:** Microprocessors and Microcontrollers

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the basic elements of embedded systems such as I/O and interfaces.
<b>CO2</b>	Understand embedded system design using the ARM Cortex-M microcontroller with the Launch pad IDE in C.
<b>CO3</b>	Develop the rapid prototype of embedded systems using microcontrollers.
<b>CO4</b>	Build wireless networked embedded systems using Arduino shields and modules (e.g., GPS, GSM/GPRS, Bluetooth, RFID, and ZigBee).
<b>CO5</b>	Exploit the advanced concepts such as networking and wireless communications, real-time operating systems and control, and Internet of Things in the real time embedded systems.
<b>CO6</b>	Develop the hardware-software co-design with parallel threads
<b>CO7</b>	Conduct experiments in Internet of Things

**Syllabus:**

### Theory

1. Introduction to Embedded Systems: Elements of embedded systems (such as microcontrollers, GPIO, communication, interrupts, ADC, and DAC); overview of microcontroller; Comparison between Hardware, Software, and Firmware; Comparison between Hard, Soft, Firm, and Hybrid real time systems; applications of embedded systems; classification of embedded systems; characteristics of embedded systems; hardware-software partitioning; (5 hours)
2. RTOS: Software aspects of embedded systems; Real-time operating system (RTOS) - mutual exclusion using semaphore; deadlock; critical section; event-driven scheduling; time sharing; earliest deadline first scheduling; pre-emptive scheduling; non-pre-emptive scheduling; multi-tasking; multi-threading; inter-process communication using mbox, and pipes; priority inversion; (10 hours)
3. Prototyping: Rapid prototyping of embedded systems with advanced microcontroller boards; (5 hours)
4. IoT: Basic elements of IoT; IoT systems design using advanced microcontroller boards; (10 hours)
5. Communication Protocols: I2C, CAN, PCIe, SPI, UART, USB (10 hours)

### Practice

1. Experiments in GPIO such as switches, LEDs, LCD, Key pad, Seven Segment Display, Buzzer, and relay; (5 hours)
2. Serial and parallel interfacing; data acquisition with ADC, audio, and video; timer interrupts; Various bus inter connects such as I2C, UART, SPI, and so on; (5 hours)
3. DAC Experiments in control of RC servos, stepper motors, and DC motors; (5 hours)
4. Data acquisition and real-time control with uC boards, FPGA boards; (5 hours)
5. Add-on boards Experiments in wireless networked systems with GPS, GSM/GPRS, ZigBee, Bluetooth, and RFID; (5 hours)

6. Hardware-software co-design experiments using FPGA boards. (5 hours)
7. Experiments in IoT for smart automation using sensors, microcontrollers, and cloud. (5 hours)
8. Free RTOS based applications and PSoC trainer board based experiments. (8 hours)

**Text Book(s):**

1. D. Gajski, F. Vahid, S. Narayan, and J. Gong. "Specification and Design of Embedded Systems", Prentice Hall.

**References & Web Resources:**

1. J. W. Valavano, "Embedded Systems: Introduction to Arm Cortex-M Microcontrollers", 2nd edition, Create Space, 2012. ISBN: 978-1477508992.
2. J. W. Valavano, "Embedded Systems (Vol-2): Real-Time Interfacing to ARM Cortex-M Microcontrollers", 2nd edition, Create Space, 2011, ISBN: 978-1463590154.
3. J. W. Valavano, "Embedded Systems (Vol-3): Real-Time Operating Systems for Arm Cortex M Microcontrollers", 2nd edition, Create Space, 2012. ISBN: 978-1466468863.
4. A. McEwen and H. Cassimally, "Designing the Internet of Things", 1st edition, Wiley, 2013. ISBN: 978-8126556861.

Course Title	Course Code	Structure (I-P-C)		
<b>Analog VLSI design</b>	EC504	<b>3</b>	<b>2</b>	<b>4</b>

**Pre-requisite, if any:** Analog Circuits

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Analyse effect of mismatch between components in the performance of ICs
<b>CO2</b>	Model MOSFET in IC
<b>CO3</b>	Analyse noise in different components in the IC
<b>CO4</b>	Derive the Data Sheet / Specifications of Single stage, two stage, folded cascode op amps
<b>CO5</b>	Understand fully differential operation, opamp and make such circuits

**Syllabus:**

**Theory**

1. Introduction of CMOS technology: Components and mismatch in CMOS process, models and Layout techniques. (4 hours)
2. MOS Transistor: Layout, model, Body effect, transit frequency. (4 hours)
3. Small signal analysis: Small signal analysis of MOSFET based amplifiers, cascode and cascode MOSFET based amplifiers (10 hours)
4. Noise: Noise in Resistor, capacitor, and MOSFET, spectral density (4 hours)
5. Differential amplifiers, current mirror, cascode current mirror, folded cascode multi stage, and Miller compensated op amps. (6 hours)
6. Single stage op amp: Noise, offset, swing limits and slew rate, Loop gain and stability Analysis in two and higher order opamp (5 hours)
7. Operational amplifiers based circuits: arithmetic circuits, oscillators, active filters. (10 hours)
8. PLL (5 hours)

**Practice**

1. Design of MOSFET based amplifiers: Schematic and layout simulation using EDA tools (15 hours)
2. Design of Op Amp based Circuits: Schematic and layout simulation using EDA tools (15 hours)

**Text Book(s):**

1. Behzad Razavi, "Design of Analog CMOS Integrated Circuits", 2nd edition McGraw-Hill Education, 2016, ISBN: 978-0-07-252493-2
2. Baker, R. Jacob, "CMOS: Circuit design, Layout, and Simulation", John Wiley & Sons, 2019.

**References & Web Resources:**

1. Tony Chan Carusone, David A. Johns, Kenneth W. Martin, "Analog Integrated Circuit Design", John Wiley & Sons, Inc., 2012, ISBN: 978-0-470-77010-8.
2. Paul R. Gray, Paul J. Hurst, Stephen H. Lewis, Robert G. Meyer, "Analysis and Design Of Analog Integrated Circuits", 5th edition, John Wiley & Sons, Inc., 2009. ISBN: 978-0-470-24599-6.
3. Tertulien Ndjountche, "CMOS Analog Integrated Circuits High-Speed and Power Efficient Design", CRC Press Taylor & Francis Group, 2011. ISBN: 978-1-4398-5500-3

Course Title	Course Code	Structure (I-P-C)		
<b>Advanced Computer Architecture</b>	EC505	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Digital Logic Circuits, Microprocessors and Microcontrollers

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Interpret the performance of a processor based on metrics such as execution time, cycles per instruction (CPI), Instruction count etc
<b>CO2</b>	Predict the challenges of realizing different kinds of parallelism (such as instruction, data, thread, core level) and leverage them for performance advancement
<b>CO3</b>	Apply the concept of memory hierarchy for efficient memory design and virtual memory to overcome the memory wall
<b>CO4</b>	Explore emerging computing trends, computing platforms, and design trade-offs Teaching Methodology
<b>CO5</b>	Design a data path of Harvard processor.

**Syllabus:**

### Theory

1. Design Space Exploration and Optimizations: Performance metrics and performance enhancement techniques, basic concepts of parallel processing and pipelining, power dissipation in processors, power metrics, low-power design techniques, and Amdhal's law (5 hours)
2. Instruction set architecture design: Instruction set design, implementation and performance perspectives, relative advantages of RISC and CISC instruction set, processor datapath design using Von Nuemann and Harvard architectures. (5 hours)
3. Instruction-level parallelism (ILP): Pipeline data-path, data-dependence. challenges in ILP realization. instruction hazards and their solutions, out-of-order execution, control hazards, branch prediction, VLIW and superscalar processors, control hazards, static and dynamic prediction, dynamic instruction scheduling using score board, Thomosulo engine, and hardware speculation. (10 hours)
4. Memory systems: Brief overview of memory technologies (SRAM, DRAM, ROM, CAM, and flash), overview of memory hierarchy, cache design considerations, instruction vs. data caches, read, write, and replacement policies in cache, analysis of cache performance, and cache design for performance enhancement, cache coherence protocols, virtual memory organization. (10 hours)
5. Data Level Parallelism: Flynn's processor classification, SIMD, MIMD, GPU architectures (5 hours)
6. Multicore implementations: tightly and loosely coupled multicore architectures (5 hours)

### Practice

1. Processor data path design (Harvard Architecture with Microprogramming based Controller) in HDL: It includes the functional units such as logic unit, fixed/floating point adder, multiplier, and divider. Here, two separate memories are used for data and instruction. (15 hours)
2. Implementation of ILP and DLP processors: dynamic instruction scheduling, hazard resolution techniques (15 hours)
3. Memory Design: cache memory design, cache coherence protocol design (5 hours)

**Text Book(s):**

1. J .L. Hennessy, D.A.Patterson, “Computer Architecture: a quantitative approach”, Morgan Kaufmann, 5th edition, 2011, ISBN: 978-1558605961.
2. William Stallings, “Computer Organization and Architecture”, Prentice Hall, 10th edition, 2015, ISBN-10: 013293633X, ISBN-13: 978-0132936330

**References & Web Resources:**

1. David E. Culler, Jaswinder Singh, and Morgan Kaufmann, “Parallel Computer Architecture: A Hardware/ Software Approach”, MK Publishers
2. C. Hamacher, Z. Vranesic and S. Zaky, “Computer Organization”, McGraw-Hill, 5th edition, 2002, ISBN: 0072320869.
3. Andrew S. Tanenbaum, “Structured Computer Organization”, Prentice Hall, 6th edition, 2012, ISBN: 978-0132916523.
4. J.P. Shen and M.H. Lipasti, “Modern Processor Design”, MCGraw Hill, Crowfordsville, 2005
5. John P. Hayes, “Computer Architecture and Organization”, McGraw Hill

Course Title	Course Code	Structure (I-P-C)		
<b>Digital Signal Processing and Architectures</b>	EC511	<b>3</b>	<b>2</b>	<b>4</b>

**Pre-requisite, if any:** Digital Signal Processing, Digital Logic Design

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the concepts of digital signal processing: Filtering Techniques and Orthogonal Transformations.
<b>CO2</b>	Develop the hardware designs of various Digital Filtering
<b>CO3</b>	Develop the hardware designs of various Orthogonal Transformations
<b>CO4</b>	Design the co-processor for digital signal processing
<b>CO5</b>	Analyse the multi rate signal processing

**Syllabus:**

### Theory

1. Digital filter design: Basics of folded/parallel design, FIR/IIR filter design, steepest- descent LMS algorithm, adaptive FIR filter design, multirate signal processing, polyphase decomposition, and filter banks. (15 hours)
2. Discrete wavelet transform: Haar wavelet, 1D/2D/3D-Convolution based discrete wavelet transform architecture, 1D/2D/3D-(5,3) and (9,7) lifting based discrete wavelet transform architecture. (10 hours)
3. FFT architectures: radix-2/4 SDF, MDC, parallel FFT architectures. (5 hours)
4. HEVC architectures: introduction to DCT, integer DCT architectures, and discrete Hadamard transform architectures. (5 hours)
5. Motion Picture Estimation: Algorithms on motion picture estimation (5 hours)

### Practice

1. Hardware/software co-design of signal processing operations (8 hours)
2. Digital Signal Co-processor design (8 hours)
3. Digital Filter Designs – FIR, IIR, Adaptive filters (8 hours)
4. Discrete Orthogonal Transform Designs – FFT, integer DCT, DHT, DWT (8 hours)
5. Experiments using DSP trainer kits (8 hours)

### Text Book(s):

1. S. K. Mitra, “Digital Signal Processing: A computer base approach”, Third edition, McGraw Hill Higher Education, 2006.
2. Y.T. Chan, “Wavelet Basics”, Kluwer Publishers, Boston, 1993.
3. Simon Haykin, “Adaptive filter theory”, Pearson Education, Fifth edition, 2014.

### References & Web Resources:

1. V. Oppenheim and R. W. Schaffer, “Discrete-time signal processing”, Second edition, Prentice Hall, 1999.



Course Title	Course Code	Structure (I-P-C)		
<b>Mixed Signal Integrated Circuits</b>	EC512	<b>3</b>	<b>2</b>	<b>4</b>

**Pre-requisite, if any:** Analog Circuits

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Design and analyze ADC and DAC using EDA tools
<b>CO2</b>	Apply the concepts for mixed signal MOS circuit
<b>CO3</b>	Analyze the signal to noise ratio and modeling of mixed signals
<b>CO4</b>	Understand the characteristics of ADC and DAC
<b>CO5</b>	Design ADC and DAC using full custom ASIC

**Syllabus:**

### Theory

1. Data converter fundamentals: Analog versus digital (or discrete time) signals, converting analog signals to data signals, sample and hold circuits, sample and hold characteristics, switched capacitor circuits, DAC specifications, ADC specifications.
2. Sample and hold and trans-linear circuits: Performance of sample-and-hold circuits – testing sample and holds, MOS sample-and-hold basics, examples of CMOS S/H Circuits, bipolar and BiCMOS Sample-and-Holds, Translinear gain Cell, trans-linear multiplier
3. DAC architectures: digital input code, R-2R ladder networks, current steering, charge scaling DACs, cyclic DAC, pipeline DAC.
4. ADC architectures: flash ADC, 2-step flash ADC, pipeline ADC, integrating ADC, successive approximation ADC.
5. Oversampling ADCs

### Practice

1. Design and analysis of DACs in VLSI CAD tools (20 hours)
2. Design and analysis of ADCs in VLSI CAD tools (20 hours)

### Text Book(s):

1. Baker, R. Jacob, “CMOS: Mixed Signal Circuit Design”, John Wiley & Sons, 2019.
2. BehzadRazavi, “Principles of Data Conversion System Design”, Wiley

### References & Web Resources:

1. Tony Chan Carusone, David A. Johns, Kenneth W. Martin, “Analog Integrated Circuit Design”, John Wiley & Sons
2. BehzadRazavi, “Design of Analog CMOS Integrated Circuits”, 2nd edition McGraw-Hill Education, 2016

Course Title	Course Code	Structure (I-P-C)		
<b>VLSI Verification and Testing</b>	EC513	<b>3</b>	<b>2</b>	<b>4</b>

**Pre-requisite, if any:** Digital Logic Circuits, VLSI Design

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Design and analyse complex VLSI systems using industry level Design and verification tools.
<b>CO2</b>	Understand the concept of yield and identify the parameters influencing the same
<b>CO3</b>	Specify fabrication defects, errors and faults.
<b>CO4</b>	Implement combinational and sequential circuit test generation algorithms
<b>CO5</b>	Identify techniques to improve fault coverage

**Syllabus:**

### Theory

1. Formal Hardware Verification: equivalence check and model check algorithms, compiler optimizations for formal verification, temporal logic, binary decision diagrams: OBDD, ROBDD, and BMD. (10 hours)

2. Introduction to VLSI Testing: Role of testing in VLSI Design flow, Testing at different levels of abstraction, Fault error, defect, diagnosis, yield, Types of testing, Rule of Ten, Defects in VLSI chip. Modelling basic concepts, Functional modelling at logic level and register level, structure models, logic simulation, delay models. (3 hours)

3. Fault Modelling: Various types of faults, Fault equivalence and Fault dominance in combinational sequential circuits. Fault simulation applications, General fault simulation algorithms- Serial, and parallel, Deductive fault simulation algorithms. Combinational circuit test generation, Structural Vs Functional test, ATPG, Path sensitization methods. (4 hours)

4. Automatic Test Pattern Generation: Difference between combinational and sequential circuit testing, five and eight valued algebra, and Scan chain based testing method. D-algorithm procedure, Problems, PODEM Algorithm, Problems on PODEM Algorithm. FAN Algorithm, Problems on FAN algorithm, Comparison of D, FAN and PODEM Algorithms. Design for Testability, Ad-hoc design, Generic scan based design. (8 hours)

5. DFT, scan chains, and BIST: Classical scan based design, System level DFT approaches, Test pattern generation for BIST, and Circular BIST, BIST Architectures, Boundary scan testing. (8 hours)

6. Memory and Delay Test: Testable memory design-Test algorithms-Test generation for Embedded RAMs, hazard free, robust, and non robust path delay fault tests, transition delay fault test. (8 hours)

7. Test Compression: Test Data Compression, Compression Methods and Decompression Methods. (4 hours)

### Practice

1. Formal Verification: Basic UVM constructs & classes, design a basic test environment using UVM, System Verilog/HDL verification features, including classes, constrained random stimulus, coverage, strings, queues and dynamic arrays, and learn how to utilize these features for more effective and efficient verification. (20 hours)

2. VLSI Testing: Verify fault coverage of test patterns, simulate fault, apply test pattern, and observe output, Hands-on on Design for test (DFT) – insert test points, scan chains, to improve testability, Writing ATPG and Designs for Combinational and Sequential Circuits, Design of LFSR for BIST, Fault Models simulations and verifications, Structural Testing with Fault Models, and Implement path delay fault testing. (20 hours)

**Text Book(s):**

1. ZainalabedinNavabi, “Digital System Test and Testable Design using HDL Models and Architecture”, 1st edition, Springer, 2010, ISBN: 978-1-4419-7547-8

2. Michael L. Bushnell and Vishwani D. Agrawal, “Essentials of Electronic Testing for Digital, Memory, and Mixed-Signal VLSI Circuits”, Springer, 2004. ISBN: 7923- 7991-8.

3. SystemVerilog for Design: A Guide to Using System Verilog for Hardware Design and Modeling, 2 nd Edition, ISBN-13: 978-0387333991

4. Erik Seligman, Tom Schubert, and M V Achutha Kiran Kumar, “Formal Verification: An Essential Toolkit for Modern VLSI Design”, MK Publishers.

**References & Web Resources:**

1. M. Abramovici, M. Breuer, and A. Friedman, “Digital Systems Testing and Testable Design, IEEE Press.

2. Chris Spear, “SystemVerilog for Verification: A Guide to Learning the Testbench Language Features”, Springer. 2012, ISBBN: 978-1461407140.

3. Donald Thomas, Logic Design and Verification Using SystemVerilog, 2016, ISBN: 1523364025.

4. “UVM Primer: A Step-by-Step Introduction to the Universal Verification Methodology”, 2013, ISBN: 0974164933.

Course Title	Course Code	Structure (I-P-C)		
<b>RFIC Design</b>	EC514	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Engineering Electromagnetics

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Analyze RF frequency filters, couplers, amplifier, oscillators and mixer circuits and LNA.
<b>CO2</b>	Design RF frequency filters, couplers, amplifiers, and LNA.
<b>CO3</b>	Design Oscillators, mixers and Phase Locked Loops
<b>CO4</b>	Develop RFICs.

**Syllabus:**

Introduction to RF and Wireless Technology: A Wireless World, RF Design Is Challenging, The Big Picture, Basic concepts in RF Design, General Considerations, Effects of Nonlinearity, Noise, Sensitivity and Dynamic Range, Passive Impedance Transformation, Scattering Parameters, Analysis of Nonlinear Dynamic Systems, Volterra Series.

Communication Concepts: General Considerations, Analog Modulation, Digital Modulation, Spectral Regrowth, Mobile RF Communications, Multiple Access Techniques, Wireless Standards.

Transceiver Architectures: General Considerations, Receiver Architectures, Transmitter Architectures.

Low Noise Amplifiers and Mixer Design: General Considerations, Problem of Input Matching, LNA Topologies, Gain Switching, Band Switching, High-IP2 LNAs, Nonlinearity Calculations, General Considerations of Mixer, Passive Downconversion Mixers, Active Downconversion Mixers, Improved Mixer Topologies, Upconversion Mixers.

Passive Devices: General Considerations, Inductors, Transformers, Transmission Lines, Constant Capacitors.

Oscillators and Phase Locked Loop: Performance Parameters, Basic Principles, Cross-Coupled Oscillator, Three-Point Oscillators, Voltage-Controlled Oscillators, Tuning Range Limitations, LC VCOs with Wide Tuning Range, Phase Noise, Low-Noise VCOs, LO Interface, Mathematical Model of VCOs, Quadrature Oscillators, Type-I PLLs, Type-II PLLs, PFD/CP Nonidealities, Phase Noise in PLLs, Loop Bandwidth, Design Procedure.

Basics of Integer-N Frequency Synthesizers, Fractional-N Synthesizers and power Amplifiers, Transceiver Design Example.

**Text Book(s):**

1. BehzadRazavi, RF Microelectronics, 2nd Edition, Pearson, 2011.

**References & Web Resources:**

1. I.D. Robertson , S. Lucyszyn, RFIC and MMIC Design and Technology: 13 (Materials, Circuits and Devices), Institution of Engineering and Technology, 2001.

Course Title	Course Code	Structure (I-P-C)		
<b>Electronic Packaging and Manufacturing</b>	EC515	<b>3</b>	<b>2</b>	<b>4</b>

**Pre-requisite, if any:** Basics of Electrical & Electronics Engineering

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understands the electronics packaging including package styles or forms, hierarchy and methods of packaging necessary for various environments.
<b>CO2</b>	Provides industry perspective in the electronics packaging
<b>CO3</b>	Ability to distinguish between engineering performance and economic considerations to develop cost-efficient and high performance packaging approaches.
<b>CO4</b>	Predict the reliability of electronic components and structures.
<b>CO4</b>	Implementation of PCB design with different application

**Syllabus:**

### Theory

1. Overview of Electronic Systems Packaging: Definition of a system and history of semiconductors, Products and levels of packaging, Packaging aspects of handheld products, Definition of PWB, Basics of Semiconductor and Process flowchart, Wafer fabrication, inspection and testing, Wafer packaging; Packaging evolution; Chip connection choices, Wire bonding, TAB and flip chip. (8 hours)
2. Electronic systems and needs, physical integration of circuits, packages, boards and complete electronic systems; system applications like computer, automobile, medical and consumer electronics with case studies and packaging levels. (8 hours)
3. Electrical design considerations - power distribution, signal integrity, RF package design and Power-delivery in systems. CAD for Printed Wiring Boards (PWBs) and Design for Manufacturability (DFM). PWB Technologies, Single-chip (SCM) and Multi-chip modules (MCM), flex circuits. Recent trends in manufacturing like microvias, sequential build-up circuits and high-density interconnect structures. (8 hours)
4. Materials and processes in electronics packaging, joining methods in electronics; lead-free solders. Surface Mount Technology - design, fabrication and assembly, embedded passive components. (8 hours)
5. Thermal management of IC and PWBs, Cooling Requirements, Electronic cooling methods thermo-mechanical reliability, design for reliability, electrical test and green packaging issues, Design for Reliability – Fundamentals, Induced failures. Electrical Testing –System level electrical testing, Interconnection tests, Active Circuit Testing, Design for Testability. Trends in packaging. (8 hours)

### Practice

1. PCB design flow- Schematic -layout - PCB design using created library - PCB printing using PCB prototyping machine-Testing and debugging of PCB. (4 hours)
2. Familiarization of different components and chip packages. (4 hours)
3. PCB Design for manufacturability. (4 hours)
4. PCB Design consideration for special circuits. (4 hours)
5. Design and development of PCBs using different simulator tools and prototyping. (4 hours)

6. Hands-on lab sessions for board manufacturing and assembly. (4 hours)

7. Thermal and Heat Sink Design. (4 hours)

8. Electrical Testing and Active Circuit Testing. (4 hours)

**Text Book(s):**

1. Rao R. Tummala, “Fundamentals of Microsystems Packaging”, McGraw Hill, NY, 2001

2. Rao R Tummala and MadhavanSwaminathan, “Introduction to System-on-Package”, McGraw Hill, 2008

3. R S Khandpur,” Printed Circuit Boards”, McGraw Hill, 2006

4. Richard K. Ulrich and William D. Brown, “Advanced Electronic Packaging”, 2nd Edition :IEEE Press, 2006

**References & Web Resources:**

1. Jan Axelson, “Making Printed Circuit Boards”, TAB/McGraw Hill, 1993

2. Ronald A. Reis, “Electronic project design and fabrication”, 6/E, Prentice Hall, 2005.

# **Departmental Electives**

Course Title	Course Code	Structure (I-P-C)		
<b>Analog and Mixed Signal Circuit Design</b>	EC521	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Analog Electronics

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Design and analyze complex analog integrated circuits using industry level analog IC Design tools
<b>CO2</b>	Design and analyze ADC and DAC using EDA tools
<b>CO3</b>	Design and analyze various MOSFET based arithmetic circuits.
<b>CO4</b>	Learn the various methods of power optimization in analog circuits.
<b>CO5</b>	Learn various circuits of design of Operational Amplifier

**Syllabus:**

Introduction: Review of single state MOS amplifiers, current mirrors, cascode current mirrors, active current mirrors, biasing techniques.

Op-amp design: Differential pair with current mirror load, single stage op-amp characteristics, single stage op-amp tradeoffs, telescopic cascode op-amp, folded cascode op-amp, two stage op-amp, fully differential single stage op-amp.

Data converter fundamentals: Analog versus digital (or discrete time) signals, converting analog signals to data signals, sample and hold circuits, sample and hold characteristics, switched capacitor circuits, DAC specifications, ADC specifications.

Data converters: DAC architectures – digital input code, R-2R ladder networks, current steering, charge scaling DACs, cyclic DAC, pipeline DAC, ADC architectures – flash ADC, 2-step flash ADC, pipeline ADC, integrating ADC, successive approximation ADC.

Phase locked loop: simple PLL, frequency/phase detectors, charge pump PLL, application as frequency multiplier.

**Text Book(s):**

1. BehzadRazavi, Design of Analog CMOS Integrated Circuits McGraw-Hill International Edition 2016.
2. Baker, R. Jacob, CMOS: Circuit design, Layout, and Simulation. John Wiley & Sons, 2019.

**References & Web Resources:**

1. Phillip E. Allen and Douglas R. Holberg, CMOS Analog Circuit Design, Oxford University Press, 2003.
2. BehzadRazavi, Fundamentals of Microelectronics, Second edition, Wiley, 2013
3. P. R. Gray, P. J. Hurst, S. H. Lewis and R. G. Meyer, Analysis And Design Of Analog Integrated Circuits, 5th edition, John Wiley & Sons, Inc., 2009.



Course Title	Course Code	Structure (I-P-C)		
<b>Artificial Intelligence and Machine Learning</b>	EC522	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Linear Algebra, Probability Theory, and Statistics

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the applications of Linear Algebra and Probability in Machine Learning
<b>CO2</b>	Familiarize with traditional and modern learning paradigms with their applications in the real-world systems
<b>CO3</b>	Adapt human training for the development of intelligent machines
<b>CO4</b>	Model any real-world practical problem in a machine-learning domain
<b>CO5</b>	Grasp the artificial neural networks with an understanding of the modern deep-learning techniques

**Syllabus:**

Introduction to machine learning: learning systems, classification, clustering, regression, separability of problems; introduction to learning paradigms: supervised, unsupervised, semi supervised, active, reinforcement with examples; cross-validation; performance evaluation metrics for classification and clustering; curse of dimensionality, feature selection, reduction and expansion, computation of Eigen co-ordinates and principle component analysis.

Recognition systems and design cycle, Non-linearly separable problems: solutions through Cover's theorem with examples, parametric learning mechanisms like Maximum likelihood, expectation maximisation, aposteriori probabilities, Instance-based learning, Lazy learning with K-nearest neighbour, Eager learning with basis functions, non-parametric learning using support vector machines (SVMs).

Artificial neural networks: Analogy of biological neural network with artificial neural network; Perceptron learning; gradient descent algorithm; multi-layer perceptrons; backpropagation algorithm; activation functions, delta rule, learning curves: overfitting and underfitting of models; Hebbian learning, self-organising feature map, radial basis function neural networks.

Deep neural networks: Introduction and advent of deep learning paradigm, solutions to vanishing and exploding gradient problems, regularisation, activation functions for deep learning, deep feed forward network, convolutional neural network (CNN), pretrained CNN models, attention network, generative models like auto-encoders and adversarial learning, recurrent neural networks, problem solving through deep learning and open areas of research.

**Text Book(s):**

1. T. M. Mitchell, Machine Learning, McGraw-Hill, 1997.
2. S. Haykin, Neural Networks: A Comprehensive Foundation. Prentice-Hall of India, 2007.

**Reference Book(s):**

1. R. O. Duda, P.E. Hart, D. G. Stork, Pattern Classification, John Wiley, 2001
2. I. Goodfellow, Y. Bengio, and A. Courville, Deep Learning, MIT Press, 2016

Course Title	Course Code	Structure (I-P-C)		
<b>Circuits for Electronic System Design</b>	<b>EC523</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Analog Electronics and Digital Logic Circuits

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Apply concepts of Analog circuits for signal conditioning, signal processing, controller circuits, and driver circuits for power electronic circuits.
<b>CO2</b>	Design transformer and different power sources for various applications
<b>CO3</b>	Understand the interface of various modules to microcontroller and learn various communication protocols
<b>CO4</b>	Perform descriptive error analysis for the circuits
<b>CO5</b>	Demonstrate key concepts in electronics circuit design, including tools, approaches, and application scenarios

**Syllabus:**

1. Introduction to Op-Amps: Op-amp Characteristics, Negative feedback, Gain of the Op-Amp
2. Analog Signal conditioning circuits: Buffering, scaling, level translation, filtering applications, Analog math circuits - arithmetic circuits, log circuits, trigonometric circuits and applications  
Timer circuits, pulse width modulation circuits, P, PI and PID controller circuits, protection circuits, base and gate drive circuits for power transistors, MOSFETs and IGBTs, relay and contactor drive circuits. Design and error budget analysis of signal conditioners for low level AC and DC applications. Error Analysis.
3. Power supply circuits: Board level power supply circuits to generate +/-12V, 5V, 3.3V, 1.8V. Linear regulators, low drop out regulators, charge pumps, switched mode power converters.
4. Interfacing circuits: A to D, D to A, A to A and D to D interfaces, serial and parallel DACs, sampling, RS-232, USB, I2C, LCD, serial memory, SPI, CAN, wireless (RF, WiFi) Ethernet, RFID, SD card, SIM card, GPS, Touchscreen interfaces.

Digital circuit essentials: Digital filters, moving average, numeric formats, scaling, normalizing, arithmetic, log, exponential, square root, cube root, hypotenuse, sine, 3 phase waves, PWM etc.

**References & Web Resources:**

1. Franco, S., Design with operational amplifiers and analog integrated circuits. Mc. GrawHillbook Co. 1988.
2. Horowitz, P., and Hill, W., The art of electronics (2nd edition), Cambridge University Press. 1992.
3. Abraham Pressman, Keith Billings, Taylor Morey, Switching Power Supply Design, McGraw-Hill Education, 2009
4. Warwick A. Smith, ARM Microcontroller Interfacing: Hardware and Software, Elektor Electronics Publishing, 2010
5. Datasheets and Application notes of different Integrated circuits.

Course Title	Course Code	Structure (I-P-C)		
<b>Cognitive Communication Networks</b>	EC524	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Signals and Systems, Analog and Digital, Wireless Communication Techniques.

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the Cognitive Communication and networking as per applications.
<b>CO2</b>	Detects the desired signal in the scrambled spectrum.
<b>CO3</b>	Understand algorithms for cognitive networks.
<b>CO4</b>	Understand the MAC protocols in cognitive networks.

**Syllabus:**

Introduction to Cognitive Radio: Introduction –Software Defined Radio: Architecture–Digital Signal Processor and SDR Baseband architecture – Reconfigurable Wireless Communication Systems – Digital Radio Processing –Cognitive Radio: Cognitive radio Framework – Functions – Paradigms of Cognitive Radio.

Spectrum Sensing: Introduction –Spectrum Sensing – Multiband Spectrum Sensing – Sensing Techniques – Other algorithms – Comparison – Performance Measure & Design Trade-Offs: Receiver operating characteristics – Throughput Performance measure –Fundamental limits and trade-offs.

Cooperative Spectrum Acquisition: Basics of cooperative spectrum sensing–Examples of spectrum acquisition techniques – cooperative transmission techniques – sensing strategies– Acquisition in the Presence of Interference: Chase combining HARQ –Regenerative cooperative Diversity–spectrum overlay– spectrum handoff.

MAC Protocols and Network Layer Design: Functionality of MAC protocol in spectrum access – classification –Interframe spacing and MAC challenges – QOS – Spectrum sharing in CRAHN – CRAHN models – CSMA/CA based MAC protocols for CRAHN – Routing in CRN– Centralized and Distributed protocols – Geographical Protocol.

**Text Book(s):**

1. Mohamed Ibnkahla, “Cooperative Cognitive Radio Networks:The complete Spectrum Cycle” I edition.
2. AhamedKhattab, Dmitri Perkins, BagdyByoumi, “Cognitive Radio Networks from Theory to Practice ” 2013th edition.

**References & Web Resources:**

1. Kwang-Cheng Chen and Ramjee Prasad, “Cognitive Radio Networks, Wiley Publications
2. Alexander M.Wyglinski,MaziarNekovee, ThomasHou,” Cognitive Radio Communications and Networks”. I edition.

Course Title	Course Code	Structure (I-P-C)		
Communication Protocols for Electronic System Design	EC525	3	0	3

**Pre-requisite, if any:** NIL

**Course Aim:** To teach fundamentals of communication protocols for designing electronic systems.

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Quantitative analysis of individual components of industrial data communications.
<b>CO2</b>	Analysis and specification of serial communication protocol standards.
<b>CO3</b>	Understanding the error detection, cable shielding techniques to avoid stray pickups, noise.
<b>CO4</b>	Systematic understanding and development of industrial communication protocols.
<b>CO5</b>	Implement the different communication protocols for different applications

### Syllabus:

**Overview:** Standards, OSI model, Protocols, Physical standards, Modern instrumentation and control systems, PLCs, Smart instrumentation systems, Communication principles and modes, error detection, Transmission, UART.

**Serial communication standards:** Standards, serial data communication interface standards, EIA-RS232 interface standard, RS-449, RS-422, RS-423 and RS-485 standards, Troubleshooting and testing with RS-485, GPIB standard, USB interface.

**Error Detection, Cabling and Electrical Noise:** Errors, Types of error detection, control and correction, copper and fiber cables, sources of electrical noise, shielding, cable ducting and earthing.

**Modems and Multiplexers:** Synchronous and Asynchronous modes, flow control, modulation techniques, types of a modem, modem standards, terminal and statistical multiplexers.

**Communication Protocols:** Flow control protocols, XON/XOFF, BSC, HDLC and File transfer protocols, OSI model and layers, ASCII protocols, Modbus protocol.

**Industrial Protocols:** Introduction to HART protocol, Smart instrumentation, HART physical layer, HART data link layer, HART application layer, ASD\_i interface, Seriplex, CANbus, Device net, Profibus, FIP bus, Fieldbus.

**Local Area Networks:** Circuit and packet switching, Network topologies, Media access control mechanisms, LAN standards, Ethernet protocol, Token ring protocol.

### References & Web Resources:

1. Practical data communications for instrumentation and control, John Park, Steve Mackay, Edwin Wright, Elsevier Newnes Publisher, 2008.
2. Computer Networks, Andrew Tanenbaum, Prentice Hall Professional Technical Reference, 2002.

Course Title	CourseCode	Structure (I-P-C)		
<b>Design of Switched Mode Power Supplies</b>	EC526	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Basic Electrical and Electronics Engg., and Control System

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Able to do the Steady-State Analysis of DC-DC power converters
<b>CO2</b>	Design switched-mode DC-DC power converters
<b>CO3</b>	Apply corresponding control techniques
<b>CO4</b>	Design transformer and different power sources for various DC-DC Applications
<b>CO5</b>	Demonstrate proficiency with computer skills (e.g., PSPICE and MATLAB) for the analysis and design of switched mode power converters.

**Syllabus:**

Switching devices: Ideal and real characteristics, control, drive and protection.

Design constraints of reactive elements in Power Electronic Systems: Design of inductor, transformer and capacitors for power electronic applications, Input filter requirement.

Switching power converters: Circuit topology, operation, steady-state model, dynamic model. PWM DC - DC Converters (CCM and DCM) - operating principles, constituent elements, characteristics, comparisons and selection criteria.

Soft-switching DC - DC Converters: Zero-voltage-switching converters, zero-current switching converters, multi-resonant converters and Load resonant converters.

Pulse Width Modulated Rectifiers: Properties of ideal rectifier, realization of near ideal rectifier, control of the current waveform, single phase and three-phase converter systems incorporating ideal rectifiers and design examples.

Review of linear control theory. Closed-loop control of switching power converters. Sample designs and construction projects.

**Text Books:**

1. R. W. Erickson and D. Maksimovic, Fundamentals of Power Electronics, 2nd Kluwer Academic Publishers, 2000. ed.,

**References:**

1. Marian K. Kazimierczuk, 'Pulse-width Modulated DC-DC Power Converters' John Wiley & Sons Ltd., 1st Edition, 2008.

2. Philip T Krein, 'Elements of Power Electronics', Oxford University Press, 2nd Edition, 2012.

3. Batarseh, 'Power Electronic Circuits', John Wiley, 2nd Edition, 2004.

4. H. W. Whittington, B. W. Flynn, D. E. Macpherson, 'Switched Mode Power Supplies', John Wiley & Sons Inc., 2nd Edition, 1997.

Course Title	Course Code	Structure (I-P-C)		
<b>Detection and Estimation Theory</b>	EC527	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Signals and Systems, Random Process, Communication Systems

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the discrete-time and continuous-time signal theory for finding unknown signal parameters.
<b>CO2</b>	Extract useful information from random observations in communications.
<b>CO3</b>	Design and analyze optimum detection schemes.
<b>CO4</b>	Estimate the error in wireless communication.
<b>CO5</b>	Understand the performance parameters in practical applications

**Syllabus:**

Detection Theory: Detection Theory in Signal Processing; the Detection Problem; the Mathematical Detection Problem; Hierarchy of Detection Problems; Role of Asymptotics.

Statistical Detection Theory: Neyman-Pearson Theorem , Receiver Operating Characteristics, Minimum Probability of Error, Multiple Hypothesis Testing, Minimum Bayes Risk Detector - Binary Hypothesis.

Deterministic Signal: Matched Filters – Development of Detector, Performance of Matched Filter; Multiple Signals – Binary case, Performance of Binary Case, M-ary case.

Random Signals: Estimator-Correlator – Energy Detector; Linear Model - Rayleigh Fading Sinusoid, Incoherent FSK for a Multipath Channel.

Estimation Theory: Estimation in Signal Processing; Mathematical Estimation Problem; Assessing Estimator Performance.

Minimum Variance Unbiased Estimation: Unbiased Estimators; Minimum Variance Criterion; Existence of the Minimum Variance Unbiased Estimator; Finding the Minimum Variance Unbiased Estimator. Estimator Accuracy Considerations; Cramer-Rao Lower Bound; General CRLB for Signals in AWGN.

Estimation Techniques: Linear Model, General Minimum Variance Unbiased Estimation, Best Linear Unbiased Estimators, Maximum Likelihood Estimation, Least Squares, Estimation.

**Text Book(s):**

1. Steven M. Kay, Fundamentals of Statistical signal processing, volume-1: Estimation theory. Prentice Hall 2011.
2. Steven M. Kay, Fundamentals of Statistical signal processing, volume-2: Detection theory, Prentice Hall 2011.

**References & Web Resources:**

1. Harry L. Van Trees, Detection, Estimation, and Modulation Theory, Part I, John Wiley & Sons, Inc. 2011.
2. A. Papoulis and S. Unnikrishna Pillai, Probability, Random Variables and stochastic processes, 4e. The McGraw-Hill 2010.

Course Title	Course Code	Structure (I-P-C)		
<b>Digital Image Processing</b>	EC528	<b>3</b>	<b>2</b>	<b>4</b>

**Pre-requisite, if any:** Digital Signal Processing

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Analyse the properties of various images
<b>CO2</b>	Manipulate the operations between the images
<b>CO3</b>	Transform the given images
<b>CO4</b>	Detect the objects in the images
<b>CO5</b>	Enhance the resolution of the images

**Syllabus:**

### Theory

1. Digital Image Fundamentals: elements of visual perception, image acquisition and display, image sampling and quantization, pixel relationship, arithmetic operations between images and super resolution (4 hours)
2. Image Transformation and Enhancement: geometric transformation, intensity transformation, spatial domain filtering, DFT, DCT, KLT and frequency domain filtering (8 hours)
3. Image and Video coding: run length coding, Huffman coding, compression using DCT, H.264/MPEG-4 advanced video coding (4 hours)
4. Image Restoration and Reconstruction: models for image degradation and restoration process, Wiener's filter, principles of Computed Tomography (CT), Image reconstruction from projections using inverse Radon transform and binary image reconstruction using network flow (6 hours)
5. Color Image Processing: color models, pseudo and full-color image processing, smoothing and sharpening in color images and segmentation based on color (4 hours)
6. Morphological Image Processing: erosion and dilation, opening and closing, boundary extraction, hole filling, connected component extraction, thinning and thickening, and grayscale morphology (6 hours)
7. Image Segmentation: point, line and edge detection, Hough transform, thresholding using Otsu's method, region based segmentation, watershed segmentation algorithm and graph-cut based segmentation (7 hours)
8. Representation, Description and Recognition of Objects: chain codes, polygonal approximation approaches, signatures, boundary segments, boundary descriptors, regional descriptors, recognition based on decision-theoretic methods, matching shape numbers and string matching (7 hours)

### Text Book(s):

1. Rafael C. Gonzalez and Richard E. Woods, "Digital Image Processing", Pearson Education, 3rd Edition, 2009

### References & Web Resources:

1. William K Pratt, "Digital Image Processing", John Willey, 4th edition, 2006.
2. A.K. Jain, "Fundamentals of Digital Image Processing", Prentice Hall of India, 1995.
3. Rafael C. Gonzalez, Richard E. Woods, and Steven L. Eddins, "Digital Image Processing using MATLAB", Pearson Education, 2nd Edition, 2009.

4. B. Chanda and D. Dutta Majumder, “Digital Image Processing and Analysis”, Prentice Hall of India, 2008

Course Title	Course Code	Structure(I-P-C)		
<b>Electrical Drives</b>	<b>EC529</b>	<b>1</b>	<b>3</b>	<b>3</b>

**Pre-requisite, if any:** Basic Electrical and Electronics Engineering

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand how power electronic converters and inverters operate.
<b>CO2</b>	Possess and understanding of feedback control theory.
<b>CO3</b>	Analyze and compare the performance of DC and AC machines.
<b>CO4</b>	Design control algorithms for electric drives which achieve the regulation of torque, speed or position in the above machines.

**Syllabus:**

Experiments conducted in this course bring out the basic concepts of different types of electrical machines and their performance.

Experiments are conducted to introduce the concept of control of conventional electric motors such as DC motor, AC Induction motor and also special machines such as Stepper motor, Permanent magnet brushless motors, Servo motor.

Speed-Torque characteristics of various types of load and drive motors are also discussed.

The working principle of various power electronic converters is also studied by conducting experiments.

**References & Web Resources:**

1. R. Krishnan, “Electric Motor Drives: Modeling, Analysis, and Control,” Prentice Hall, 2001.
2. .Mohan, “Electric Drives: An Integrative Approach,” MNPERE, 2001.



Course Title	Course Code	Structure (I-P-C)		
<b>Electromagnetic Interference and Compatibility</b>	EC530	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Electromagnetic Waves and Transmission Lines

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Gain knowledge to understand the concept of EMI / EMC related to product design.
<b>CO2</b>	Understand the various standards of EMI/EMC.
<b>CO3</b>	Diagnose and solve various electromagnetic compatibility problems.
<b>CO4</b>	Understand the sources of EMI and various coupling methods.
<b>CO5</b>	Learn the various methods of doing the pre-compliance measurement techniques.

**Syllabus:**

Introduction to EMI and EMC: Various EMC requirements and standards-Need for EMC and its importance in electronic product design - sources of EMI - few case studies on EMC.

Conducted and radiated emission: power supply line filters-common mode and differential mode current-common mode choke-switched mode power supplies.

Shielding techniques: shielding effectiveness-shield behaviour for the electric and magnetic field - aperture-seams-conductive gaskets- conductive coatings.

Grounding techniques: signal ground-single point and multi-point grounding-system ground common impedance coupling -common mode choke-Digital circuit power distribution and grounding.

Contact protection: arc and glow discharge-contact protection network for inductive loads-C, RC, RCD protection circuit- inductive kickback.

RF and transient immunity: transient protection network- RFI mitigation filter-power line disturbance- ESD- human body model- ESD protection in system design.

PCB design for EMC compliance: PCB layout and stack up- multi-layerPCB objectives Return path discontinuities-mixed signal PCB layout.

EMC pre-compliance measurement: conducted and radiated emission test-LISN- Anechoic chamber.

**Text Book(s):**

1. H. W. Ott, Electromagnetic Compatibility Engineering, 2nd edition, John Wiley & Sons, 2011, ISBN: 9781118210659.
2. C. R. Paul, Introduction to Electromagnetic Compatibility, 2nd edition, Wiley India, 2010, ISBN: 9788126528752.

**References & Web Resources:**

1. K. L. Kaiser, Electromagnetic Compatibility Handbook, 1st edition, CRC Press, 2005. ISBN: 9780849320873.

Course Title	Course Code	Structure (I-P-C)		
<b>MIMO Communication Systems</b>	EC531	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Signals and Systems, Analog and Digital Communications, and Wireless Communication.

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the concept of MIMO communication techniques, Channel Capacity, MIMO algorithms.
<b>CO2</b>	Understand power allocation strategies for practical MIMO systems.
<b>CO3</b>	Design algorithms of MIMO to improve the bit rate.
<b>CO4</b>	Understand MIMO in 5G communication.
<b>CO5</b>	Understand the MIMO reception in various channel conditions

**Syllabus:**

Introduction: Diversity-multiplexing trade-off, transmit diversity schemes, advantages and applications of MIMO systems.

Analytical MIMO channel models: Uncorrelated, fully correlated, separately correlated and keyhole MIMO fading models, parallel decomposition of MIMO channel.

Power allocation in MIMO systems: Uniform, adaptive and near optimal power allocation.

MIMO channel capacity: Capacity for deterministic and random MIMO channels, Capacity of i.i.d., separately correlated and keyhole Rayleigh fading MIMO channels.

Space-Time codes: Advantages, code design criteria, Alamouti space-time codes, SER analysis of Alamouti space-time code over fading channels, Space-time block codes, Space-time trellis codes, Performance analysis of Space-time codes over separately correlated MIMO channel, Space-time turbo codes.

MIMO detection: ML, ZF, MMSE, ZF-SIC, MMSE-SIC, LR based detection.

Advances in MIMO wireless communications: Spatial modulation, MIMO based cooperative communication and cognitive radio, multiuser MIMO, cognitive-femtocells and large MIMO systems for 5G wireless.

**Text Book(s):**

1. R. S. Kshetrimayum, Fundamentals of MIMO Wireless Communications, Cambridge University Press, 2017.
2. A. Chokhalingam and B. S. Rajan, Large MIMO systems, Cambridge University Press, 2014.

**References & Web Resources:**

1. B. Kumbhani and R. S. Kshetrimayum, MIMO Wireless Communications over Generalized Fading Channels, CRC Press, 2017
2. T. L. Marzetta, E. G. Larsson, H. Yang and H. Q. Ngo, Fundamentals of Massive
3. MIMO, Cambridge University Press, 2016.

Course Title	Course Code	Structure (I-P-C)		
<b>Numerical Techniques in Electromagnetics</b>	EC532	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Electromagnetic Waves and Transmission Lines

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand how to computational solve different structures using Maxwell equations.
<b>CO2</b>	Understand various computational techniques and their pros and cons.
<b>CO3</b>	Understand which software works best in terms of speed, and accuracy for analysing a given structure
<b>CO4</b>	Develop codes to analyze the EM structures.
<b>CO5</b>	Gain knowledge need to develop EM simulation software tools

**Syllabus:**

Review of vector calculus, Overview of computational electromagnetic, Review of Maxwell's equations.

Analytical techniques in Electromagnetics.

Finite Difference Time Domain methods: Analysis, convergence, accuracy and numerical dispersion, incorporating dielectric and dispersive materials, absorbing boundary conditions, perfectly matched layers (PML), sources.

Moment Methods: Integral equations (EFIE,MFIE), Green's Functions, MOM.

Finite element methods: Formulation and Absorbing boundary conditions (FEM).

Applications of computational electromagnetic: Specific Absorption Rate, Radar RCS, Periodic structures, Eddy current calculations, capacitance and inductance calculations, Microwave inverse imaging, Antenna radiation problems, Calculating the modes of a waveguide structure using the integral equation method.

**Text Book(s):**

1. Numerical Techniques in Electromagnetic, Second Edition Hardcover – Import, 12 July 2000, by Matthew N.O. Sadiku
2. Analytical and Computational Methods in Electromagnetic, Artech House Electromagnetic Analysis, 30 September 2008, by Ramesh Garg, Raj Mittra

**References & Web Resources:**

1. Computational Electromagnetics for RF and Microwave Engineering, 28 October 2010, by David B. Davidson
2. Advanced Engineering Electromagnetics Paperback - 8 October 2008, by Constantine A. Balanis
3. Computational Methods for Electromagnetics: 4 (IEEE Press Series on Electromagnetic Wave Theory) Hardcover – Import, 12 December 1997, by Andrew F. Peterson, Scott L. Ray, Raj Mittra

Course Title	Course Code	Structure(I-P-C)		
<b>Power Electronics</b>	<b>EC533</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite,ifany:** Electronic Devices

**CourseOutcomes:**Atthe endofthe course,thestudentwillbeableto:

<b>CO1</b>	Understand basic operation of various power semiconductor devices and passive components
<b>CO2</b>	Understandthebasicprinciple ofswitchingcircuits.
<b>CO3</b>	DesignAC/DCrectifier,DC/DCconverterandDC/ACinvertercircuits.
<b>CO4</b>	Understandtherolepowerelectronicplayintheimprovementofenergyusage,efficiencyandthedevelopmentofrenewableenergytechnologies.
<b>CO5</b>	Design different power converters

### Syllabus:

Introduction topowerelectronics; applicationsandroleofpowerelectronics.

Introductiontopowersemiconductordevices,operatingcharacteristicsofPowerDiode,SCR,Power BJT, PowerMOSFET andIGBT;DrivercircuitsandSnubbercircuits.

Introduction to AC/DC rectifiers, principle of operation of phase controlled rectifiers, singlephaseandthreephaseAC-DClinecommutatedconverters,dualconverter,andintroductiontounitypowerfactorconverters. Applications: DCmotordrivesandBattery chargers.

Introduction to DC/DC converters, Principle of operation of DC/DC (Buck, Boost, Buck-Boost, Cuk, Fly-back and Forward) converters. Applications: Power supply, DC motor drivesand SMPS.

Introductionto DC/AC inverters, PWMtechniques, Principleof operationof single phaseand three phase DC-AC inverters, Applications: AC motor drives, UPS, active filters, CFL,renewable power generation,inductionanddielectricheating.

### Text Book:

1. N.Mohan,T.Undeland,andW.Robbins,“PowerElectronics:Converters,Applications, andDesign,”3rdEdition,Wiley,2003.
2. M.Rashid,“PowerElectronics:Circuits,Devices&Applications,”Prentice Hall,3rdEdition,2003.

### References & Web Resources:

1. J.P.Agrawal,“PowerElectronic Systems:TheoryandDesign,”Pearson,2013.
2. Batarseh,“PowerElectronicCircuits,”JohnWiley,2004.2.R.W.EricksonandD.Maksimovic,“Fundamentals ofPowerElectronics,”2ndEdition,Springer,2001.
3. R.W.EricksonandD.Maksimovic,“FundamentalsofPowerElectronics,” 2<sup>nd</sup>Edition,Springer,2001.

Course Title	Course Code	Structure (I-P-C)		
<b>Reliable Digital Communication System Design</b>	EC534	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Communication Systems, Digital Logic Design

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Learn the functional behaviour of various cryptography, intrusion detection, and error correction algorithms.
<b>CO2</b>	Learn to develop hardware architectures of various cryptography, intrusion detection, and error correction algorithms.
<b>CO3</b>	Develop the countermeasure prototypes of adversary attacks
<b>CO4</b>	Develop the crypto co-processors using FPGA.
<b>CO5</b>	Understand the algorithms of cryptography.

**Syllabus:**

Information theory, Entropy, Properties of Entropy

Goals of Relilable Digital Communication: first level of defense (integrity, confidentiality, authenticity, and availability) and second level of defense (resilience to attacks).

Galois Field Arithmetic: Introduction to Group, Ring, and Fields, Prime/Polynomial field representation, Irreducible polynomial, primitive polynomial, minimal polynomial, Galois field addition, LSB first/MSB first/Montgomery Galois field multiplication architectures-bit serial, bit parallel, digit serial, systolic, and scalable architectures, Modular exponentiators-Square-multiply algorithm and Montgomery Ladder algorithm, Extended Euclidean algorithm/Fermat's little theorem based multiplicative inverse architectures.

Symmetric Encryption/Decryption Architectures: DES, 3-DES, and AES (fully folded, parameterized parallel, and fully parallel architectures).

Asymmetric Encryption/Decryption Architectures: ECC (right-to-left, left-to-right, Montgomery based scalar multiplication in affine/projective co-ordinates) and RSA.

HASH architectures: SHA512 and SHA3.

Key exchange protocols: DiffieHelmen, Elgamal, Neuro crypto key exchange protocol.

Authentication schemes: Yang Shieh and EijiOkamoto.

Pseudo random number generators, Stream ciphers.

Physical unclonable functions: RO PUF, larger decoder memory based PUF, and XOR PUF.

Intrusion Detection: Universal HASH functions, Cuckoo hashing, and Bloom filter.

Error detection codes: CRC, LRC, and parity check, Error correction codes-Hamming, BCH, Reed Solomon, LDPC, Convolutional, Turbo product, and concatenated codes, Hardware/software co-design analogous between ASIC/FPGA/hardware-software co-designs, need for crypto accelerators (or coprocessors), and hardware/software partitioning based AES/ECC architectures.

Side channel analysis: Power attack, Bit masking, and Cache template attack.

**Text Book(s):**

1. Doug R. Stinson , Cryptography Theory and Practice, Third Edition, CRC Press, 2006.
2. Shu Lin and Daniel J Castello, Error Control Coding, Second Edition, Printice Hall, 2004.
3. Haykin, An Introduction to Analog and Digital Communications, wiley Vol 2, 2008.

**References & Web Resources:**

1. A. J. Menezes, P. C. van Oorshot, and S. A. Vanstone, Handbook of Applied Cryptography, CRC Press, 1996.
2. Jonathan Katz and Yehuda Lindell, Introduction to Modern Cryptography, CRC Press, 2015.
3. DebdeepMukhopadhyay and RajatSubhra Chakraborty, Hardware Security: Design, Threats and Safeguards, CRC Press, 2014.

Course Title	Course Code	Structure (I-P-C)		
<b>RF and Microwave Integrated Circuits</b>	EC535	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Electromagnetic Waves and Transmission Lines, and Analog Electronics

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the differences in designing low frequency ICs, RFICs, and MMICs.
<b>CO2</b>	Analyse high frequency filters, couplers, amplifier, oscillators and mixer circuits.
<b>CO3</b>	Design high frequency filters, couplers, amplifiers.
<b>CO4</b>	Develop RFICs.
<b>CO5</b>	Develop MMICs.

**Syllabus:**

Electromagnetic Theory Review: Maxwell's Equations, Fields in Media and Boundary Conditions, The Wave Equation, General Plane Wave Solutions, Energy and Power, Transmission lines and waveguide solutions.

Transmission Line Theory: The Lumped-Element Circuit Model for a Transmission Line, Field Analysis of Transmission Lines, The Terminated Lossless Transmission Line, The Smith Chart, The Quarter-Wave Transformer, Generator and Load Mismatches, Lossy Transmission Lines, Transients on Transmission Lines.

Microwave Network Analysis: Impedance and Equivalent Voltages and Currents, Impedance and Admittance Matrices, The Scattering Matrix, The Transmission (ABCD) Matrix.

Impedance matching and tuning, Microwave filter design.

Noise and nonlinear distortion, active rf and microwave devices.

Microwave Power Amplifier, Low Noise Amplifier, Oscillator and Mixer Design.

Introduction to microwave systems.

**Text Book(s):**

1. David M Pozar, Microwave Engineering, 4th Edition, Wiley, 2013.
2. Behzad Razavi, RF Microelectronics, 2nd Edition, Pearson, 2011.

**References & Web Resources:**

1. Robert E Collin, Foundations for Microwave Engineering, 2nd Edition, Wiley, 2007.
2. I.D. Robertson, S. Lucyszyn, RFIC and MMIC Design and Technology: 13 (Materials, Circuits and Devices), Institution of Engineering and Technology, 2001.

Course Title	Course Code	Structure (I-P-C)		
<b>Satellite Communication</b>	EC536	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Signals and Systems, Analog and Digital, Wireless Communication Techniques.

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the satellite communication.
<b>CO2</b>	Understand the orbits and space of satellite communication.
<b>CO3</b>	Understand the optical communication.
<b>CO4</b>	Develop the packet switched networks.
<b>CO5</b>	Understand the importance of Optical technology in space applications

**Syllabus:**

**OVERVIEW OF SATELLITE SYSTEMS, ORBITS AND LAUNCHING METHODS:**

Introduction, Frequency Allocations for Satellite Services, Intelsat, U. S. Domsats Polar Orbiting Satellites, Problems, Kepler's First Law, Kepler's Second Law, Kepler's Third Law, Definitions of Terms for Earth-orbiting Satellites, Orbital Elements, Apogee and Perigee Heights, Orbital Perturbations, Effects of a Non-spherical Earth, Atmospheric Drag, Inclined Orbits, Calendars, Universal Time, Julian Dates, Sidereal Time, The Orbital Plane, The Geocentric, Equatorial Coordinate System, Earth Station Referred to the IJK Frame, The Top centric-Horizon Coordinate System, The Sub-satellite Point, Predicting Satellite Position.

**GEOSTATIONARY ORBIT & SPACE SEGMENT:**

Introduction, Antenna Look Angles, The Polar Mount Antenna , Limits of Visibility , Near Geostationary Orbits, Earth Eclipse of Satellite, Sun Transit Outage, Launching Orbits, Problems, Power Supply, Attitude Control, Spinning Satellite Stabilization, Momentum Wheel Stabilization, Station Keeping, Thermal Control, TT&C Subsystem , Transponders, Wideband Receiver, Input De-multiplexer, Power Amplifier, Antenna Subsystem, Morelos, Anik-E, Advanced Tiros-N Spacecraft.

**OPTICAL NETWORK ARCHITECTURES:**

Introduction to Optical Networks; Layered Architecture- Spectrum partitioning, Network Nodes, Network Access Stations, Overlay Processor, Logical network overlays, Connection Management and Control; Static and Wavelength Routed Networks; Linear Light wave networks; Logically Routed Networks; Traffic Grooming; The Optical Control Plane- Architecture, Interfaces, Functions; Generalized Multiprotocol Label Switching – MPLS network and protocol stack, Link management, Routing and Signaling in GMPLS.

**OPTICAL PACKET SWITCHED NETWORKS:**

Network Architectures- Unbuffered Networks, Buffering Strategies; OPS enabling technologies, Test beds; Optical Burst Switching, Switching protocols, Contention Resolution, Optical Label Switching, OLS network test beds, Control and Management – Network management functions, Configuration management, Performance management, Fault management, Optical safety, Service interface; network Survivability- Protection in SONET / SDH and IP Networks, Optical layer Protection, Interworking between layers.

**FREE SPACE OPTICAL COMMUNICATION:**

Analog and digital FSOC data link, atmospheric attenuation, scattering, scintillation index, beam wandering, beam wave front aberration, adaptive optics, active optics, deformable mirror control, RoFSO, atmospheric channel models, estimation of refractive index, modulation and demodulation techniques, error control techniques.



**Text Book(s):**

1. Satellite Communications, Dennis Roddy, McGraw-Hill Publication Third edition 2001
2. Satellite Communications – Timothy Pratt, Charles Bostian and Jeremy Allnut, WSE, Wiley Publications, 2nd Edition, 2003.

**References & Web Resources:**

1. Timothy Pratt – Charles Bostian & Jeremy Allnut, Satellite Communications, John Wiley & Sons (Asia) Pvt. Ltd. 2004
2. Wilbur L. Pritchard Henri G. Snyder Robert A. Nelson, Satellite Communication Systems Engineering, Pearson Education Ltd., Second edition 2003.
3. Satellite Communications: Design Principles – M. Richharia, BS Publications, 2<sup>nd</sup> Edition, 2003.
4. J. Gower, “Optical Communication System”, Prentice Hall of India, 2001
5. Rajiv Ramaswami, “Optical Networks”, Second Edition, Elsevier, 2004.
6. Satellite Communications Engineering – Wilbur L. Pritchard, Robert A Nelson and Henri G. Snyder, 2nd Edition, Pearson Publications, 2003.
7. Optical Fiber Communication – John M. Senior – Pearson Education – Second Edition. 2007
8. Optical Fiber Communication – Gerd Keiser – McGraw Hill – Third Edition. 2000

Course Title	Course Code	Structure(I-P-C)		
<b>Sensing and Instrumentation</b>	<b>EC537</b>	<b>1</b>	<b>3</b>	<b>3</b>

**Pre-requisite, if any: Nil**

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Build systems which would sense the different physical signals
<b>CO2</b>	Process the signals in the required analog or digital formats
<b>CO3</b>	Calibrate sensors according to the required applications.
<b>CO4</b>	Understand the characteristics of transducers.

**Syllabus:**

Transducers, transducer sensing and functions, Passive and active – Resistance, inductance and capacitance, Strain Gauges, Hall Effect sensors, Optical sensors.

Measurement of non-electrical quantities such as displacement, velocity, acceleration, pressure, force, flow and temperature, calibration of sensors, Data acquisition and detection techniques, Signal conversion, PC-based Instrumentation System.

Practice includes experiments from following topics:

Signal generation – Instrumentation amplifiers – Signal conversion and processing – Characteristics of Transducers – Calibration of sensors – Measurement of physical quantities.

**Text Book(s):**

1. Alan S. Morris, Measurement and Instrumentation Principles, Elsevier, 2001.
2. Sawhney. A. K, Course in Electrical & Electronics Measurement & Instrumentation, Dhanpat Rai, 2007.

**References & Web Resources:**

1. Howard Austerlitz, Data acquisition techniques using PCs, Academic Press, 2nd Ed. 2002.
2. Bruce Mihura, LabVIEW for Data Acquisition (National Instruments Virtual Instrumentation Series), Prentice Hall, 2001.

Course Title	Course Code	Structure(I-P-C)		
<b>Signal and Power Integrity</b>	<b>EC538</b>	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any: Nil**

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the design guidelines to be followed in PCB design and IC packaging to prevent Signal and Power Integrity issues.
<b>CO2</b>	Analyze the physical structure and dimensions of the PCB elements and fit an appropriate circuit model.
<b>CO3</b>	Analyze the measured voltages and currents in the PCB and find the causes of the signal integrity issues.
<b>CO4</b>	Analyze the measured voltages and currents in the PCB and find the causes of the power integrity issues.
<b>CO5</b>	Design an optimal layout for a PCB to avoid signal and power integrity issues.

**Syllabus:**

Signal Integrity Is in Your Future: What Are Signal Integrity, Power Integrity, and Electromagnetic Compatibility?, Signal-Integrity Effects on One Net, Cross Talk, Rail-Collapse Noise, Electromagnetic Interference (EMI), Two Important Signal-Integrity Generalizations, Trends in Electronic Products, The Need for a New Design Methodology, A New Product Design Methodology.

Time and Frequency Domains: The Time Domain, Sine Waves in the Frequency Domain, Shorter Time to a Solution in the Frequency Domain, Sine-Wave Features, The Spectrum of a Repetitive Signal, The Spectrum of an Ideal Square Wave, Frequency Domain to the Time Domain, Effect of Bandwidth on Rise Time, Bandwidth and Rise Time, Bandwidth of Real Signals, Bandwidth and Clock Frequency, Bandwidth of a Measurement, Bandwidth of a Model, Bandwidth of an Interconnect.

Impedance and Electrical Models, The Physical Basis of Resistance, Capacitance, Inductance, and Transmissions lines.

Transmission Lines and Reflections, Lossy Lines, Rise-Time Degradation, and Material Properties, Cross Talk in Transmission Lines.

Differential Pairs and Differential Impedance, S-Parameters for Signal-Integrity Applications, The Power Distribution Network (PDN)

**Text Book(s):**

1. Bogatin, Eric. Signal and power integrity-simplified. Pearson Education, 2010.

**References & Web Resources:**

1. Johnson, Howard, Howard W. Johnson, and Martin Graham. High-speed signal propagation: advanced black magic. Prentice Hall Professional, 2003.
2. Johnson, Howard W., and Martin Graham. High-speed digital design: a handbook of black magic. Vol. 155. Englewood Cliffs, NJ: Prentice Hall, 1993.

Course Title	Course Code	Structure (I-P-C)		
<b>Software Defined Radio</b>	EC539	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Signals and Systems, Analog and Digital, Wireless Communication Techniques.

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the SDR, CR, and their applications.
<b>CO2</b>	Understand the signal processing architectures used in the SDR.
<b>CO3</b>	Develop the FPGA based SDR.
<b>CO4</b>	Develop microcontroller based SDR.

**Syllabus:**

**INTRODUCTION TO SDR:** What is Software-Defined Radio, The Requirement for Software-Defined Radio, Legacy Systems, The Benefits of Multi-standard Terminals, Economies of Scale, Global Roaming, Service Upgrading, Adaptive Modulation and Coding, Operational Requirements, Key Requirements, Reconfiguration Mechanisms, , Handset Model, New Base-Station and Network, Architectures, Separation of Digital and RF, Tower-Top Mounting, BTS Hoteling, Smart Antenna Systems, Smart Antenna System Architectures, Power Consumption Issues, Calibration Issues, Projects and Sources of Information on Software Defined Radio.

**BASIC ARCHITECTURE OF A SOFTWARE DEFINED RADIO:** Software Defined Radio Architectures, Ideal Software Defined Radio Architecture, Required Hardware Specifications, Digital Aspects of a Software Defined Radio, Digital Hardware, Alternative Digital Processing Options for BTS Applications, Alternative Digital Processing Options for Handset Applications, Current Technology Limitations, A/D Signal-to-Noise Ratio and Power 343 Consumption, Derivation of Minimum Power Consumption, Power Consumption Examples, ADC Performance Trends, Impact of Superconducting Technologies on Future SDR Systems.

**SIGNAL PROCESSING DEVICES AND ARCHITECTURES:** General Purpose Processors, Digital Signal Processors, Field Programmable Gate Arrays, Specialized Processing Units, Tileria Tile Processor, Application-Specific Integrated Circuits, Hybrid Solutions, Choosing a DSP Solution. GPP-Based SDR, Non real time Radios, High-Throughput GPP-Based SDR, FPGA-Based SDR, Separate Configurations, Multi-Waveform Configuration, Partial Reconfiguration, Host Interface, Memory-Mapped Interface to Hardware, Packet Interface, Architecture for FPGA-Based SDR, Configuration, Data Flow, Advanced Bus Architectures, Parallelizing for Higher Throughput, Hybrid and Multi-FPGA Architectures, Hardware Acceleration, Software Considerations, Multiple HA and Resource Sharing, Multi-Channel SDR.

**COGNITIVE RADIO : TECHNIQUES AND SIGNAL PROCESSING:**History and background, Communication policy and Spectrum Management, Cognitive radio cycle, Cognitive radio architecture, SDR architecture for cognitive radio, Spectrum sensing Single node sensing: energy detection, cyclostationary and wavelet based sensing- problem formulation and performance analysis based on probability of detection vs SNR. Cooperative sensing: different fusion rules, wideband spectrum sensing- problem formulation and performance analysis based on probability of detection vs SNR.

**COGNITIVE RADIO: HARDWARE AND APPLICATIONS:** Spectrum allocation models. Spectrum handoff, Cognitive radio performance analysis. Hardware platforms for Cognitive radio (USRP, WARP), details of USRP board, Applications of Cognitive radio.

**Text Book(s):**

1. "RF and Baseband Techniques for Software Defined Radio" Peter B. Kenington, ARTECH HOUSE, INC © 2005.
2. "Implementing Software Defined Radio", Eugene Grayver, Springer, New York Heidelberg Dordrecht London, ISBN 978-1-4419-9332-8 (eBook) 2013.

**References & Web Resources:**

1. "Cognitive Radio Technology", by Bruce A. Fette, Elsevier, ISBN 10: 0-7506-7952-2, 2006.
2. "Cognitive Radio, Software Defined Radio and Adaptive Wireless Systems", Hüseyin Arslan, Springer, ISBN 978-1-4020-5541-6 (HB), 2007.

Course Title	Course Code	Structure (I-P-C)		
<b>Testing and Testability</b>	EC540	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Digital Logic Design

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Identify the significance of testable design
<b>CO2</b>	Understand the concept of yield and identify the parameters influencing the same
<b>CO3</b>	Specify fabrication defects, errors and faults.
<b>CO4</b>	Implement combinational and sequential circuit test generation algorithms
<b>CO5</b>	Identify techniques to improve fault coverage

**Syllabus:**

Role of testing in VLSI Design flow, Testing at different levels of abstraction, Fault error, defect, diagnosis, yield, Types of testing, Rule of Ten, Defects in VLSI chip. Modelling basic concepts, Functional modelling at logic level and register level, structure models, logic simulation, delay models.

Various types of faults, Fault equivalence and Fault dominance in combinational sequential circuits. Fault simulation applications, General fault simulation algorithms- Serial, and parallel, Deductive fault simulation algorithms. Combinational circuit test generation, Structural Vs Functional test, ATPG, Path sensitization methods.

Difference between combinational and sequential circuit testing, five and eight valued algebra, and Scan chain based testing method. D-algorithm procedure, Problems, PODEM Algorithm, Problems on PODEM Algorithm. FAN Algorithm, Problems on FAN algorithm, Comparison of D, FAN and PODEM Algorithms. Design for Testability, Ad-hoc design, Generic scan based design.

Classical scan based design, System level DFT approaches, Test pattern generation for BIST, and Circular BIST, BIST Architectures, and Testable memory design-Test algorithms-Test generation for Embedded RAMs.

Fault Diagnosis Logic Level Diagnosis - Diagnosis by UUT reduction - Fault Diagnosis for Combinational Circuits - Self-checking design - System Level Diagnosis.

**Text Book(s):**

1. M. Abramovici, M. Breuer, and A. Friedman, "Digital Systems Testing and Testable Design, IEEE Press, 1990
2. Stroud, "A Designer's Guide to Built-in Self-Test", Kluwer Academic Publishers, 2002

**References & Web Resources:**

1. M. Bushnell and V. Agrawal, "Essentials of Electronic Testing for Digital, Memory & Mixed-Signal VLSI Circuits", Kluwer Academic Publishers, 2000
2. V. Agrawal and S.C. Seth, Test Generation for VLSI Chips, Computer Society Press.1989.
3. M. Abramovici, M.A. Breuer and A.D. Friedman, "Digital Systems and Testable Design", Jaico Publishing House.
4. M.L. Bushnell and V.D. Agrawal, "Essentials of Electronic Testing for Digital, Memory and Mixed-Signal VLSI Circuits", Kluwer Academic Publishers.
5. P.K. Lala, "Digital Circuit Testing and Testability", Academic Press, 2002.
6. A.L. Crouch, "Design Test for Digital IC's and Embedded Core Systems", Prentice Hall International.

Course Title	Course Code	Structure (I-P-C)		
<b>VLSI Technology</b>	EC541	<b>3</b>	<b>2</b>	<b>4</b>

**Pre-requisite, if any:** Electronic Devices

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Appreciate the intricacies involved in VLSI circuit fabrication.
<b>CO2</b>	Understand the various processes needed to fabricate the VLSI devices.
<b>CO3</b>	Learn fabrication steps for existing and coming generation devices.

**Syllabus:**

### Theory

1. Introduction to VLSI Design, Bipolar Junction Transistor Fabrication, MOSFET Fabrication. (3 hours)
2. Crystal Structure of Si, Defects in Crystal, Crystal growth (3 hours)
3. Epitaxy, Vapour phase Epitaxy, Doping during Epitaxy, Molecular beam Epitaxy (3 hours)
4. Oxidation – Kinetics, Rate constants, Dopant Redistribution, Oxide Charges (3 hours)
5. Diffusion-Theory of Diffusion, Doping Profiles, Diffusion Systems Ion Implantation - Process, Annealing of Damages, Masking during Implantation (3 hours)
6. Lithography, immersion lithography, e-beam lithography (3 hours)
7. Etching-Wet Chemical Etching, Dry Etching, Plasma Etching, Si, SiO<sub>2</sub>, SiN and other materials (3 hours)
8. Deposition-Plasma Deposition, Metallization, Problems in Aluminium Metal contacts, Copper interconnects (3 hours)
9. IC BJT - LOCOS, Trench isolation, Poly-emitter-poly-base-BJT and its suitability for high-speed applications (3 hours)
10. MOSFET - Metal gate vs. Self-aligned Poly-gate, Tailoring of Device Parameters, CMOS Technology, Latch - up in CMOS, MOSFET structures with strained channels and high-k gate dielectrics, Bi-CMOS Technology, introduction to FINFETs (3 hours)
11. Small-Dimension Effects of MOSFET: Modelling for Circuits Simulation- Quantum-Mechanical Effects; Gate Current, Junction Leakage, Scaling and New Technologies, Approaches, and Properties of Good Models, Model Formulation Considerations, Parameter Extraction, Compact Models, Benchmark Tests (7 hours)
12. Small-Signal Modelling of MOSFET: Conductance Parameter Definitions and Equivalent Circuits, Conductance Parameters Due to Gate and Body Leakage, Transconductance, Source-Drain and Output Conductance, Capacitance Definitions and Equivalent Circuits, Capacitance Evaluation and Properties, y-Parameter Model, RF Models (6 hours)

### Practice

1. Simulation of various properties of Si, SiO<sub>2</sub>, SiN and other materials (40 hours)

**Text Book(s):**

1. S. K. Ghandhi, “VLSI Fabrication Principles- Silicon and Gallium Arsenide”, Wiley Publications.
2. Y. Tsividis and C. McAndrew, “MOSFET modelling for Circuit Simulation”, Oxford University Press, 2011

**References & Web Resources:**

1. S. M. Sze, “VLSI Technology”, Tata McGraw Hill, 2008
2. J. Plummer, M. D. Deal, and P. B. Griffin, “Silicon VLSI Technology, Fundamentals, Practice and Modeling”, Pearson Higher Education, 2000
3. T. A. Fjeldly, T. Yetterdal, and M. Shur, “Introduction to Device Modeling and Circuit Simulation”, John Wiley, 1998.
4. Y. Taur and T. H. Ning, “Fundamentals of Modern VLSI Devices”, Cambridge University Press, 1998.



Course Title	Course Code	Structure (I-P-C)		
<b>Design of IoT System</b>	EC542	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Microprocessors and Microcontrollers.

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the networking with IoT, its enabling technologies, and explore a young, but rich, body of exciting ideas, solutions, and paradigm shifts.
<b>CO2</b>	Understanding the potential of IoT devices, support for networking according to the protocol standards, and being able to program them, would be useful for real time applications.
<b>CO3</b>	Develop the rapid prototypes of IoT based embedded systems using sensors, cloud.
<b>CO4</b>	Develop the IoT system using Arduino, Raspberry Pi, BeagleBone Black, and Intel Edison/Galileo.
<b>CO5</b>	Implement an IoT System with Cloud

**Syllabus:**

Introduction to IoT: Definition, Trend, IoT applications, Sensing and Actuation, IoT Devices and deployment models, Power awareness of IoT, LDO in IoT.

IoT Networking: Basic IoT Components, Interdependencies, Service Oriented Architecture.

IoT Data Protocols: MQTT, SMQTT, CoAP, XMPP, AMQP.

IoT Communication Protocols and their applications: IEEE 802.15.4, ZigBee6LoWPAN, Wireless HART, Z-Wave, ISA 100, Bluetooth, and Bluetooth low energy (BLE), NFC, RFID, WiFi for IoT communications.

Data Handling, Analytics, Data management for IoT: Data cleaning and processing, Data storage models, Searching in IoT, Deep Web Semantic Sensor Web, Semantic web data management, Real-time and Big data analytics for IoT, High-dimensional data processing, Parallel and Distributed data processing.

Interoperability in IoT: Low power Interoperability for IPV6 IoT.

Cloud-Centric IoT: Architecture, Open Challenges, Energy efficiency, QoS, QoE.

Industrial IoT (IIoT): Industrial IoT and its benefits, Future of IIoT, Challenges, Examples.

IoT System Management and Virtualization: IoT environment management over Cloud computing framework, Fog Computing paradigm for IoT with case studies, Softwarized control and virtualization technologies for IoT network and computation resource management.

Case Studies: Sensor body-area-network, Smart cities and Smart homes, Agriculture.

IoT Network Framework: Wireless Network Fundamental for IoT communication tutorials with demonstrations and hands-on: 802.11 and 802.15.4 MAC Fundamentals, Management Operations, Security Overview, Network Core Protocols, Tizen Network Stack Architecture, Introduction, CAPI Architecture Overview, Sync/Async Operation Sequence, Interaction of Network Core Components, P2P Core Component Overview, OEM Layer, Suppliment Plugin Architecture overview.

**Text Book(s):**

1. The Internet of Things: Enabling Technologies, Platforms, and Use Cases, by EethurumRaj and Anupama C. Raman (CRC Press).
2. Internet of Things: A Hands-on Approach, by ArshdeepBahga and Vijay Madiseti (Universities Press).

**References & Web Resources:**

1. AdrianMcEwen, HakimCassimally, Designing the Internet of Things, Wiley, Nov 2013, (1st edition)
2. Martin Charlier, Alfred Lui, Claire Rowland, Elizabeth Goodman, Ann Light, Designing Connected Products, May 2015, O'Reilly Media.

Course Title	Course Code	Structure (I-P-C)		
<b>Electric Vehicle Technology</b>	EC543	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Basic Electrical and Electronics Engineering

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	To understand about basics of electric vehicle
<b>CO2</b>	To understand drives and control.
<b>CO3</b>	Select battery, battery indication system for EV applications
<b>CO4</b>	Design battery charger for an EV
<b>CO5</b>	Design a basic Electric Vehicle

**Syllabus:**

Introduction to Electric Vehicle : Review of Conventional Vehicle: Introduction to Electric Vehicles: Types of EVs, Electric Drive-train, Tractive effort in normal driving.

Electric Drives : Basic concept of electric traction, introduction to various electric drive-train topologies, power flow control in electric drive-train topologies, fuel efficiency analysis. Introduction to electric components used in hybrid and electric vehicles, Configuration and control of DC Motor drives, Configuration and control of Induction Motor drives, configuration and control of Permanent Magnet Motor drives, Configuration and control of Switched Reluctance Motor drives, drive system efficiency.

Energy Storage : Introduction to Energy Storage Requirements in Electric Vehicles: - Battery based energy storage and its analysis, Fuel Cell based energy storage and its analysis, Hybridization of different energy storage devices. Sizing the drive system, Sizing the propulsion motor, sizing the power electronics, selecting the energy storage technology, Communications, supporting subsystems.

Energy Management System : Energy Management Strategies, Automotive networking and communication, EV charging standards, V2G, G2V, V2B, V2H. Business: E-mobility business, electrification challenges, Business- E-mobility business, electrification challenges.

Mobility and Connectors : Connected Mobility and Autonomous Mobility- case study E-mobility Indian Roadmap Perspective. Policy: EVs in infrastructure system, integration of EVs in smart grid, social dimensions of EVs. Connectors- Types of EV charging connector, North American EV Plug Standards, DC Fast Charge EV Plug Standards in North America, CCS (Combined Charging System), CHAdeMO, Tesla, European EV Plug Standards.

**Text Book(s):**

1. Emadi, A. (Ed.), Miller, J., Ehsani, M., “Vehicular Electric Power Systems” Boca Raton, CRC Press, 2003
2. Husain, I. “Electric and Hybrid Vehicles” Boca Raton, CRC Press, 2010.

**References & Web Resources:**

1. Larminie, James, and John Lowry, “Electric Vehicle Technology Explained” John Wiley and Sons, 2012
2. Tariq Muneer and Irene IllescasGarcía, “The automobile, In Electric Vehicles: Prospects and Challenges”, Elsevier, 2017
3. Sheldon S. Williamson, “Energy Management Strategies for Electric and Plug-in Hybrid Electric Vehicles”, Springer, 2013
4. Patents of TESLA

Course Title	Course Code	Structure (I-P-C)		
<b>Navigation System</b>	EC544	<b>3</b>	<b>0</b>	<b>3</b>

**Pre-requisite, if any:** Nil

**Course Outcomes:** At the end of the course, the students will be able to:

<b>CO1</b>	Understand the concept of GNSS, AGNSS, Radio Positioning and Integration of Navigation technique.
<b>CO2</b>	Analyze navigation in various terrestrial situations.
<b>CO3</b>	Find the exact location of an object in the navigation system.
<b>CO4</b>	Design precision navigation systems.

**Syllabus:**

**INTRODUCTION TO NAVIGATION:** What Is Navigation, Position Fixing, Dead Reckoning, Inertial Navigation, Radio and Satellite Navigation, Terrestrial Radio Navigation, Satellite Navigation, Feature Matching, The Complete Navigation System.

**NAVIGATION MATHEMATICS:** Coordinate Frames, Kinematics, and the Earth: Coordinate Frames, Kinematics, Earth Surface and Gravity Models, Frame Transformations, Coriolis force.

**INERTIAL NAVIGATION:** Inertial-Frame Navigation Equations, Earth-Frame Navigation Equations, Local-Navigation-Frame Navigation Equations, Navigation Equations Precision, Initialization and Alignment, INS Error Propagation, Platform INS, Horizontal-Plane Inertial Navigation.

**PRINCIPLES OF RADIO POSITIONING:** Radio Positioning Configurations and Methods, Positioning Signals, User Equipment, Propagation, Error Sources, and Positioning Accuracy.

**GNSS: FUNDAMENTALS, SIGNALS, AND SATELLITES:** Fundamentals of Satellite Navigation, The Systems: Global Positioning System, GLONASS, Galileo, Beidou, **REGIONAL NAVIGATION SYSTEMS:** Beidou and Compass, QZSS, IRNSS, **GNSS INTEROPERABILITY:** Frequency Compatibility, User Competition, Multi-standard User Equipment Augmentation Systems, System Compatibility, GNSS Signals, Navigation Data Messages.

**ADVANCED SATELLITE NAVIGATION:** Differential GNSS, Carrier-Phase Positioning and Attitude, Poor Signal-to-Noise Environments, Multipath Mitigation, Signal Monitoring, Semi-Codeless Tracking.

**TERRESTRIAL RADIO NAVIGATION:** Point-Source Systems, Loran, Instrument Landing System, Urban and Indoor Positioning, Relative Navigation, Tracking, Sonar Transponders. (

**FEATURE MATCHING:** Terrain-Referenced Navigation, Sequential Processing, Batch Processing, Performance, Laser TRN, Barometric TRN, Sonar TRN, Image Matching, Scene Matching by Area Correlation, Continuous Visual Navigation, Map Matching, Other Feature-Matching Techniques, Stellar Navigation, Gravity Gradiometry, Magnetic Field Variation. (6 hours)

**INS/GNSS Integration:** Integration Architectures, System Model and State Selection, Measurement Models, Advanced INS/GNSS Integration.

**Text Book(s):**

1. Principles of GNSS, Inertial, and Multisensor Integrated Navigation Systems, Paul D. Groves Artech House, 2008 and 2013 Second Edition.
2. B.HofmannWollenhof, H.Lichtenegger, andJ.Collins, “GPS Theory and Practice”, Springer Wien, new York, 2000.

**References & Web Resources:**

1. Pratap Misra and Per Enge, “Global Positioning System Signals, Measurements, and Performance,” Ganga-Jamuna Press, Massachusetts, 2001.
2. Ahmed El-Rabbany, “Introduction to GPS,” Artech House, Boston, 2002.
3. Bradford W. Parkinson and James J. Spilker, “Global Positioning System: Theory and Applications,” Volume II, American Institute of Aeronautics and Astronautics, Inc., Washington, 1996.